

D-NE1/NE9

SERVICE MANUAL

Ver. 1.6 2006.03



Photo : D-NE9

US Model
D-NE1

Canadian Model
AEP Model
D-NE1/NE9

UK Model
D-NE1

E Model
Australian Model
Chinese Model
Tourist Model
D-NE1/NE9

US and foreign patents licensed from Dolby Laboratories.

Model Name Using Similar Mechanism	NEW
CD Mechanism Type	CDM-3325ER2
Optical Pick-up Name	DAX-25E

SPECIFICATIONS

System

Compact disc digital audio system

Laser diode properties

Material: GaAlAs

Wavelength: $\lambda = 780 \text{ nm}$

Emission duration: Continuous

Laser output: Less than $44.6 \mu\text{W}$

(This output is the value measured at a distance of 200 mm from the objective lens surface on the optical pick-up block with 7 mm aperture.)

D-A conversion

1-bit quartz time-axis control

Frequency response

20 - 20 000 Hz $^{+1}_{-2}$ dB (measured by JEITA CP-307)

Output (at 4.5 V input level)

Line output (stereo minijack)

Output level 0.7 V rms at 47 k Ω

Recommended load impedance over 10 k Ω

Headphones (stereo minijack)

Approx. 5 mW + Approx. 5 mW at 16 Ω

(Approx. 1.5 mW + Approx. 1.5 mW at 16 Ω)*

*For the customers in Europe

Optical digital output (optical output connector)

Output level: -21 - -15 dBm

Wavelength: 630 - 690 nm at peak level

Power requirements

For the area code of the model you purchased, check the upper left side of the bar code on the package.

- Two Sony NH-14WM (A) rechargeable batteries: 1.2 V DC \times 2
- Two LR6 (size AA) batteries: 1.5 V DC \times 2
- AC power adaptor (DC IN 4.5 V jack):
US, Canadian and Taiwan models:

120V, 60 Hz

UK model: 230 V, 50 Hz

Australian model: 240V, 50 Hz

AEP, Tourist, E18, Korean and East Europe models:

100 - 240 V, 50/60 Hz

Hong Kong model: 230 V, 50 Hz

Chinese model: 220 V, 50 Hz

Battery life*1 (approx. hours)

(When you use the CD player on a flat and stable surface)

Playing time varies depending on how the CD player is used.

When using two NH-14WM (A) (charged for about 5 hours*2)
< > : NH-10WM

	G-PROTECTION	
	"1"	"2"
Audio CD	35 <25>	32 <23>
ATRAC3plus file*3	55 <40>	55 <40>
MP3 file*4	50 <35>	50 <35>

When using external battery case (two alkaline batteries*5)

	G-PROTECTION	
	"1"	"2"
Audio CD	55	50
ATRAC3plus file*3	95	95
MP3 file*4	85	85

When using two NH-14WM (A) and external battery case (two alkaline batteries*5)
< > : NH-10WM

	G-PROTECTION	
	"1"	"2"
Audio CD	90 <80>	82 <73>
ATRAC3plus file*3	150 <135>	150 <135>
MP3 file*4	135 <120>	135 <120>

- Abbreviation

E18: 100-230V AC area in E model

— Continued on next page —

PORTABLE CD PLAYER

9-877-308-07

2006C16-1

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Sony Corporation

Personal Audio Division

Published by Sony Techno Create Corporation

SONY®

*1 Measured value by the standard of JEITA (Japan Electronics and Information Technology Industries Association)

*2 Charging time varies depending on how the rechargeable battery is used.

*3 Recorded at 48 kbps or 64 kbps

*4 Recorded at 128 kbps

*5 When using Sony alkaline batteries LR6 (SG) (produced in Japan)

Operating temperature

5°C - 35°C (41°F - 95°F)

Dimensions (w/h/d) (excluding projecting parts and controls)

Approx. 135.4 × 135.4 × 15.8 mm
(5 3/8 × 5 3/8 × 5/8 in.)

Mass (excluding accessories)

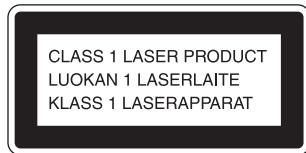
Approx. 179 g (6.4 oz.)

Supplied accessories

- AC power adaptor (1)
- Rechargeable batteries (2)
- Battery carrying case (1)
- Headphones / earphones (1)
- Remote control (1)
- Charging stand (1)
- Carrying pouch (1)
- External battery case (1)
- CD-ROM (Sonic Stage Simple Burner) (1)
- User's guide for Sonic Stage Simple Burner (1)

Design and specifications are subject to change without notice.

This appliance is classified as a CLASS 1 LASER product. The CLASS 1 LASER PRODUCT MARKING is located on the rear exterior.



CAUTION

Use of controls or adjustments or performance of procedures other than those specified herein may result in hazardous radiation exposure.

Flexible Circuit Board Repairing

- Keep the temperature of the soldering iron around 270 °C during repairing.
- Do not touch the soldering iron on the same conductor of the circuit board (within 3 times).
- Be careful not to apply force on the conductor when soldering or unsoldering.

Notes on chip component replacement

- Never reuse a disconnected chip component.
- Notice that the minus side of a tantalum capacitor may be damaged by heat.

On AC power adaptor

- Use only the AC power adaptor supplied or recommended in "Accessories (supplied/optional)." Do not use any other AC power adaptor. It may cause a malfunction.

Polarity of the plug



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Unleaded solder

Boards requiring use of unleaded solder are printed with the lead-free mark (LF) indicating the solder contains no lead.

(Caution: Some printed circuit boards may not come printed with the lead free mark due to their particular size.)



LF : LEAD FREE MARK

Unleaded solder has the following characteristics.

- Unleaded solder melts at a temperature about 40°C higher than ordinary solder.
Ordinary soldering irons can be used but the iron tip has to be applied to the solder joint for a slightly longer time.
Soldering irons using a temperature regulator should be set to about 350°C.
Caution: The printed pattern (copper foil) may peel away if the heated tip is applied for too long, so be careful!
- Strong viscosity
Unleaded solder is more viscous (sticky, less prone to flow) than ordinary solder so use caution not to let solder bridges occur such as on IC pins, etc.
- Usable with ordinary solder
It is best to use only unleaded solder but unleaded solder may also be added to ordinary solder.

SECTION 1 SERVICING NOTE

NOTES ON HANDLING THE OPTICAL PICK-UP BLOCK OR BASE UNIT

The laser diode in the optical pick-up block may suffer electrostatic breakdown because of the potential difference generated by the charged electrostatic load, etc. on clothing and the human body. During repair, pay attention to electrostatic breakdown and also use the procedure in the printed matter which is included in the repair parts.

The flexible board is easily damaged and should be handled with care.

NOTES ON LASER DIODE EMISSION CHECK

The laser beam on this model is concentrated so as to be focused on the disc reflective surface by the objective lens in the optical pick-up block. Therefore, when checking the laser diode emission, observe from more than 30 cm away from the objective lens.

SAFETY-RELATED COMPONENT WARNING!!

COMPONENTS IDENTIFIED BY MARK \triangle OR DOTTED LINE WITH MARK \triangle ON THE SCHEMATIC DIAGRAMS AND IN THE PARTS LIST ARE CRITICAL TO SAFE OPERATION. REPLACE THESE COMPONENTS WITH SONY PARTS WHOSE PART NUMBERS APPEAR AS SHOWN IN THIS MANUAL OR IN SUPPLEMENTS PUBLISHED BY SONY.

ATTENTION AU COMPOSANT AYANT RAPPORT À LA SÉCURITÉ!

LES COMPOSANTS IDENTIFÉS PAR UNE MARQUE \triangle SUR LES DIAGRAMMES SCHÉMATIQUES ET LA LISTE DES PIÈCES SONT CRITIQUES POUR LA SÉCURITÉ DE FONCTIONNEMENT. NE REMPLACER CES COMPOSANTS QUE PAR DES PIÈCES SONY DONT LES NUMÉROS SONT DONNÉS DANS CE MANUEL OU DANS LES SUPPLÉMENTS PUBLIÉS PAR SONY.

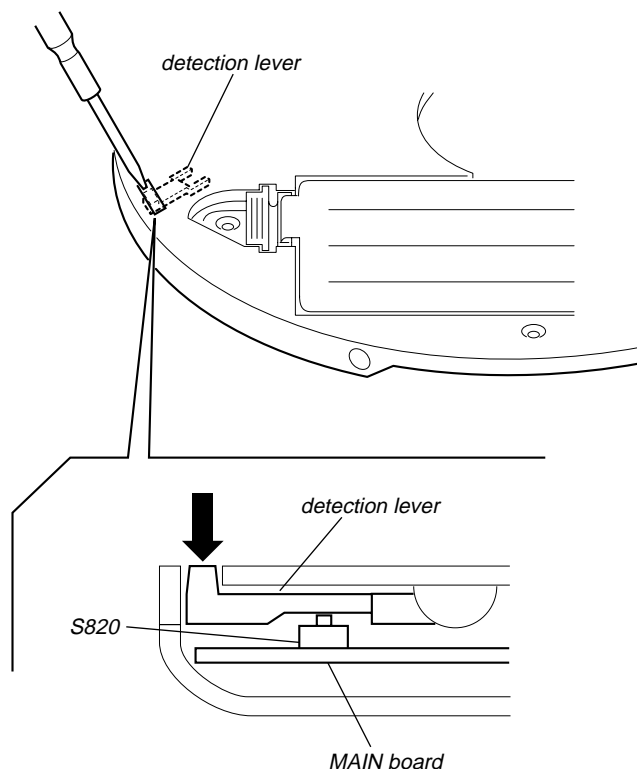


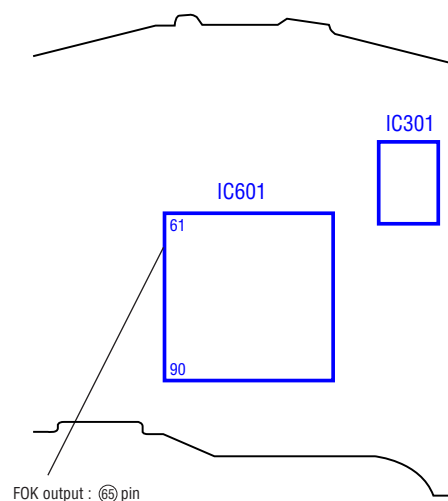
Fig. 1 Method to push the S820

BEFORE REPLACING THE OPTICAL PICK-UP BLOCK

Please be sure to check thoroughly the parameters as per the "Optical Pick-Up Block Checking Procedures" (Part No.: 9-960-027-11) issued separately before replacing the optical pick-up block. Note and specifications required to check are given below.

- FOK output: IC601 $\text{\textcircled{69}}$ pin
When checking FOK, remove the lead wire to disc motor.
- RF signal P-to-P value: 0.45 to 0.65 Vp-p

[MAIN BOARD] (SIDE B)



LASER DIODE AND FOCUS SEARCH OPERATION CHECK

During normal operation of the equipment, emission of the laser diode is prohibited unless the upper lid is closed while turning ON the S820. (push switch type)

The following checking method for the laser diode is operable.

- **Method:**
Emission of the laser diode is visually checked.
1. Open the upper lid.
 2. With a disc not set, turn on the S820 with a screwdriver having a thin tip as shown in Fig.1.
 3. Press the **▶||** button.
 4. Observing the objective lens, check that the laser diode emits light.

When the laser diode does not emit light, automatic power control circuit or optical pickup is faulty.

In this operation, the objective lens will move up and down 4 times along with inward motion for the focus search.

SERVICE MODE

The following confirmation can be performed when the Service Mode is set.

1. How to set the Service Mode.

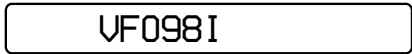
To set the Service Mode, the following method is available.

- 1) Confirm the set is not powered on.
- 2) Confirm the following settings.
OPEN/CLOSE detect switch (S820) OFF
Solder Land (SL825) OPEN
[AVLS] switch (S821) NORM
[HOLD] switch (S810) OFF
[G-PROTECTION] switch (S811) 1
- 3) Short the solder land SL824 (TEST) on the MAIN board.
- 4) Turn on the main power.

2. Operation when the Service Mode is set.

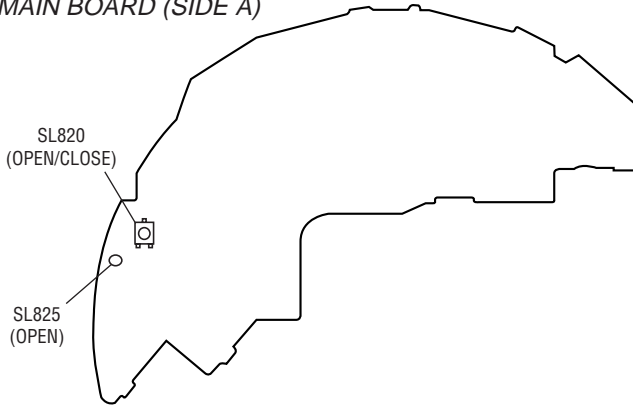
When the Service Mode becomes active, following messages are displayed on the remote control LCD.

Microcomputer
version display

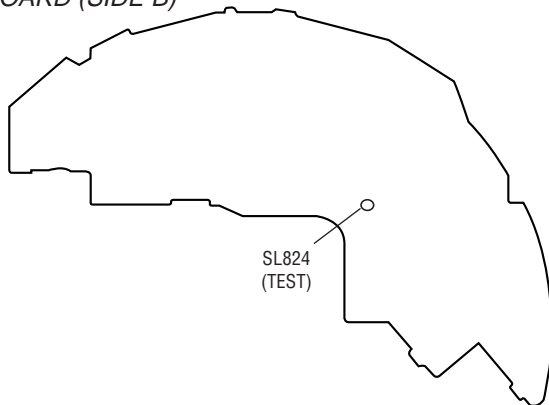


- 1) Turn off the power.
- 2) Open the solder land SL824 (TEST) on the MAIN board.
Nota : The solder should be removed clean.

MAIN BOARD (SIDE A)



MAIN BOARD (SIDE B)

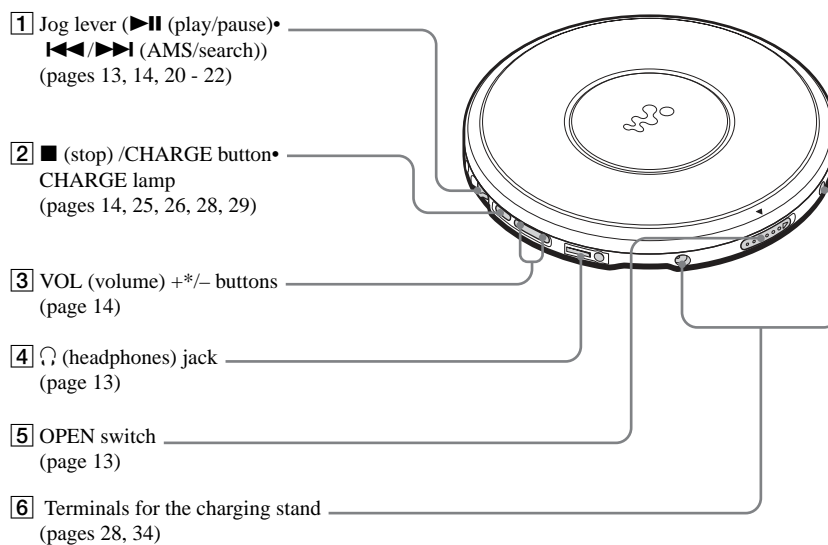


SECTION 2 GENERAL

This section is extracted from instruction manual.

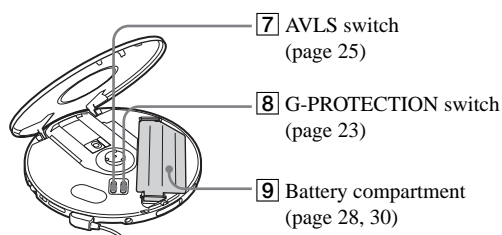
Locating the controls

CD player (front) (D-NE1)

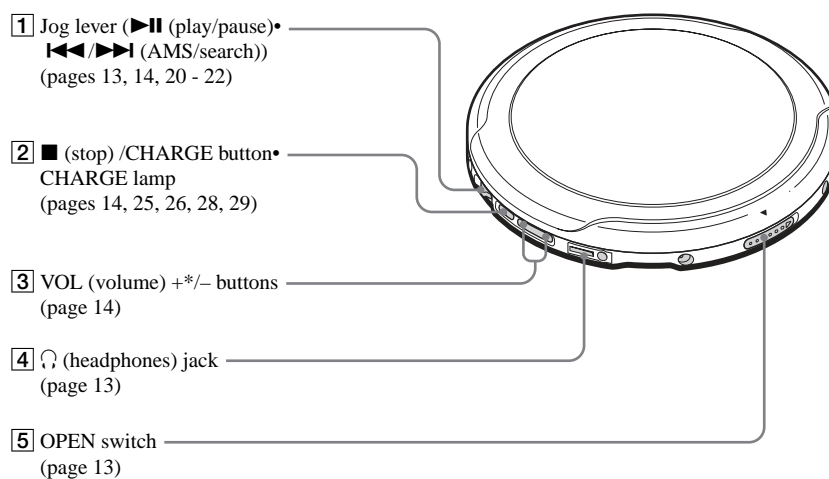


*The button has a tactile dot.

CD player (inside)

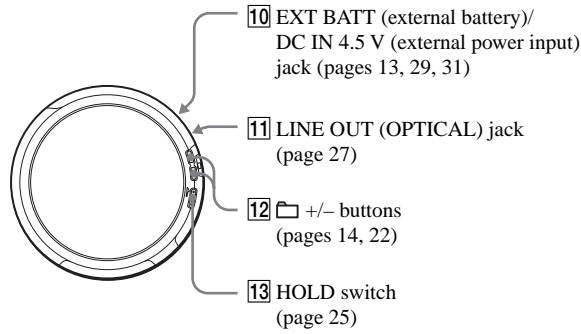


CD player (front) (D-NE9)

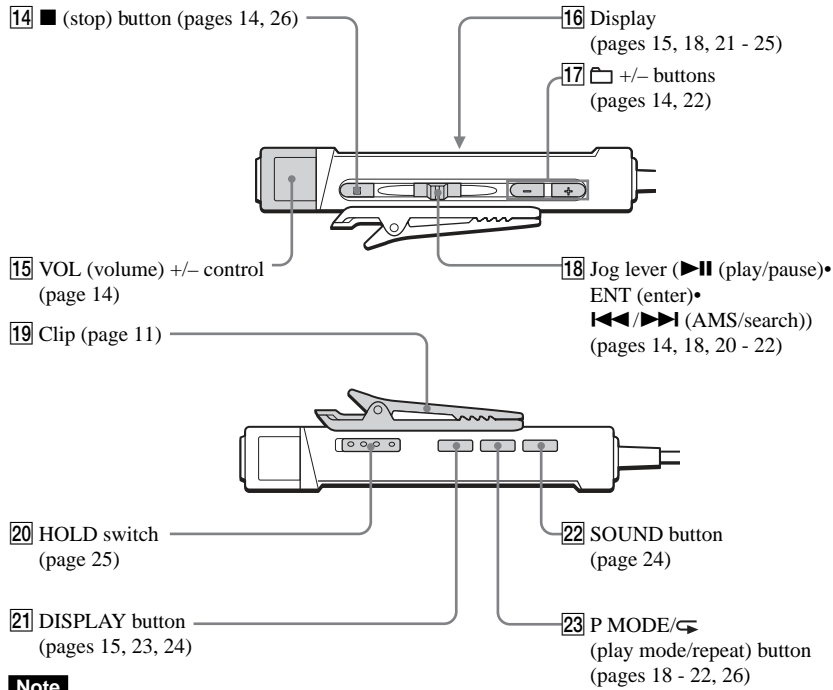


*The button has a tactile dot.

CD player (rear)



Remote control

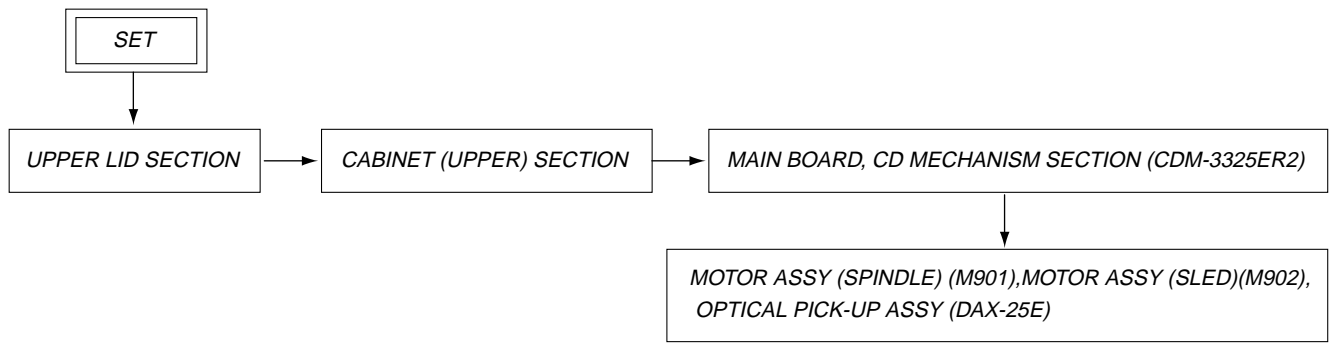


Note

Use only the supplied remote control. You cannot operate this CD player with the remote control supplied with other CD players.

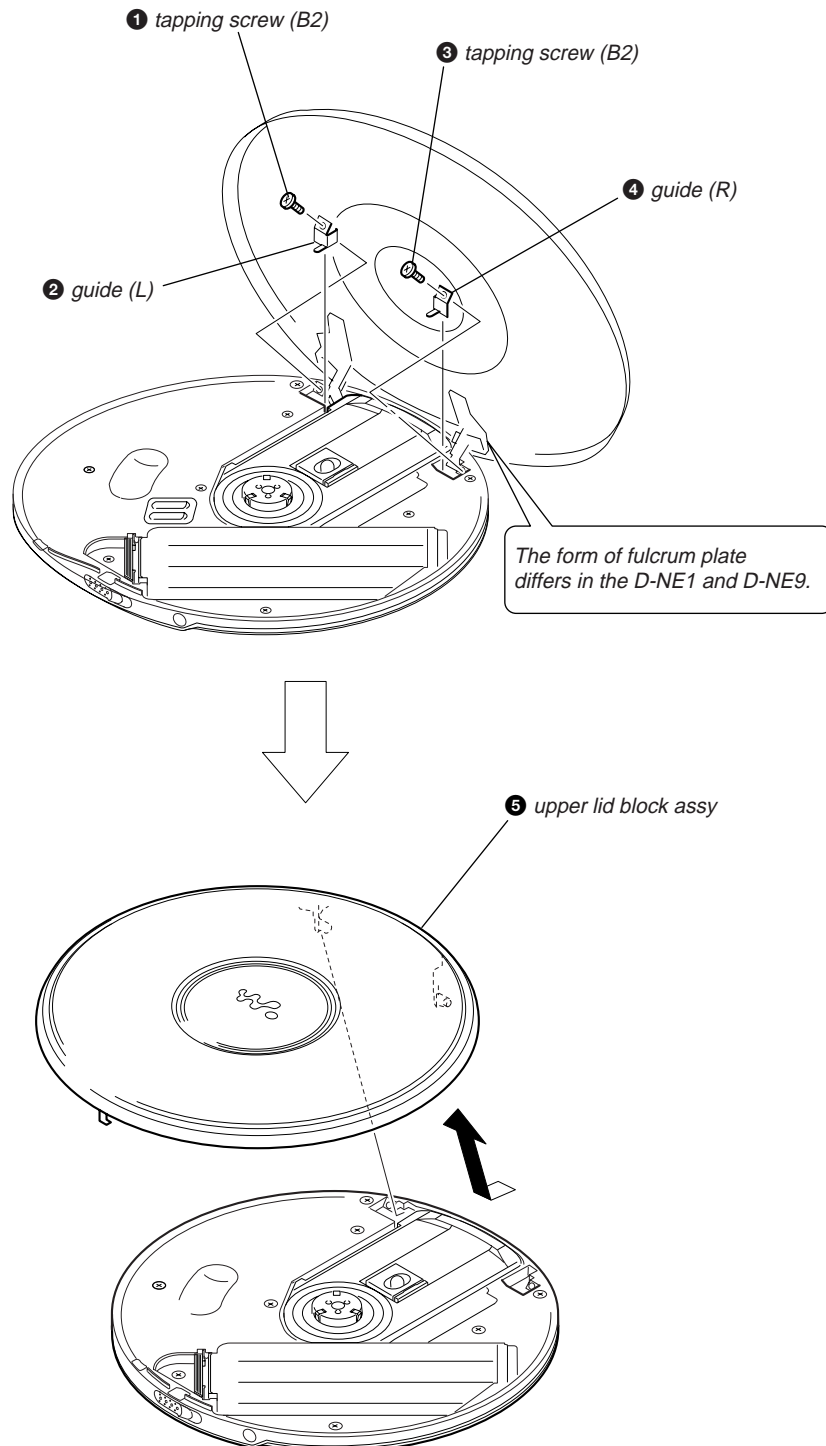
SECTION 3 DISASSEMBLY

Note : Disassemble the unit in the order as shown below.

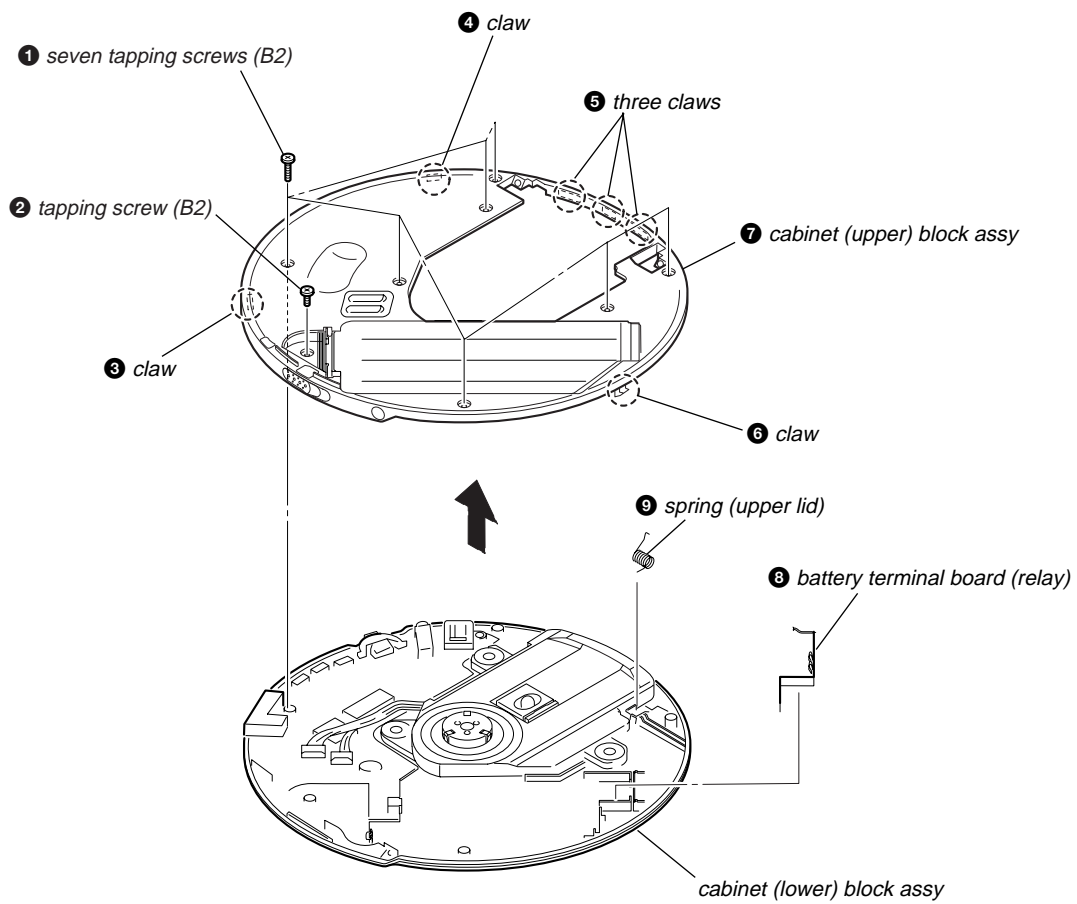


Note : Follow the disassembly procedure in the numerical order given.

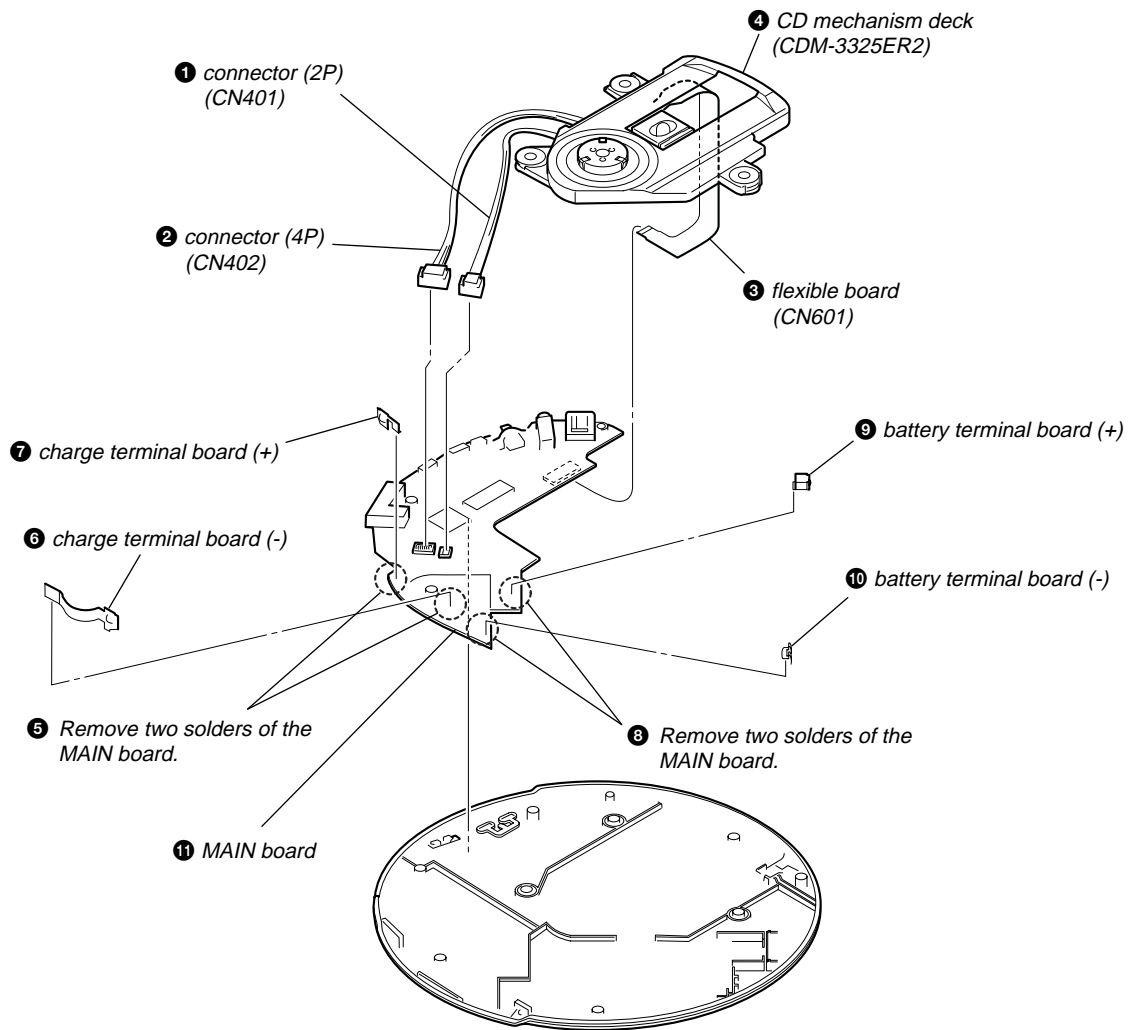
3-1. Upper Lid Section



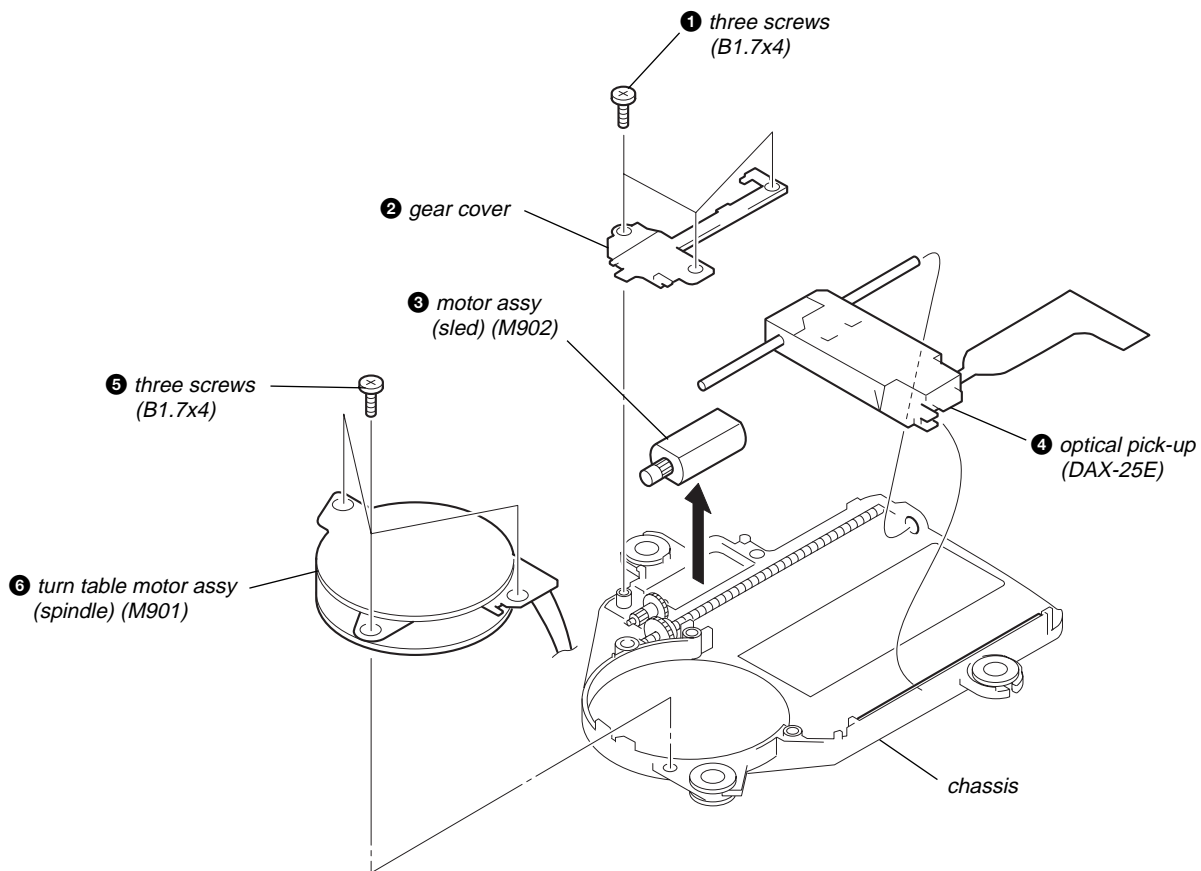
3-2. Cabinet (upper) Section



3-3. MAIN Board, CD Mechanism Section (CDM-3325ER2)



3-4. Motor Assy (Spindle)(M901), Motor Assy (Sled)(M902), Optical Pick-up Assy (DAX-25E)



SECTION 4 ELECTRICAL CHECKING

The CD section adjustments are done automatically in this set.
In case of operation check, confirm that RF level.

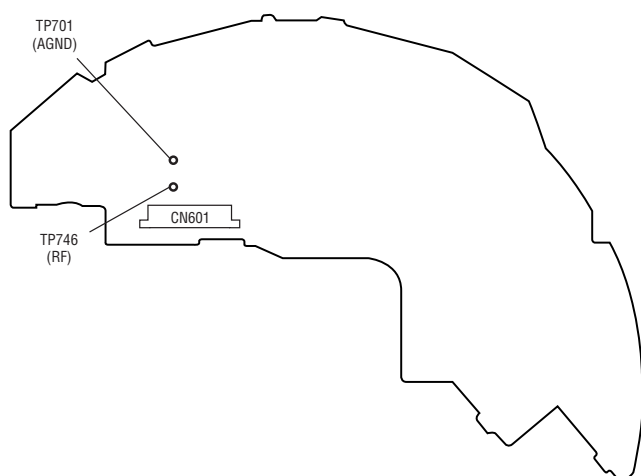
Precautions for Check

1. Perform check in the order given.
2. Use YEDS-18 disc (Part No.: 3-702-101-01) unless otherwise indicated.
3. Power supply voltage requirement : DC4.5 V in DC IN jack.
(J401)

VOLUME button : Minimum
AVLS switch : NORM
HOLD switch : OFF
G-PROTECTION switch : 1

Checking Location:

– MAIN board (Side B) –

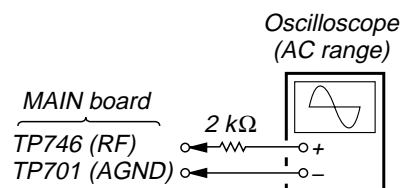


RF Level Check

Condition:

- Hold the set in horizontal state.

Connection:

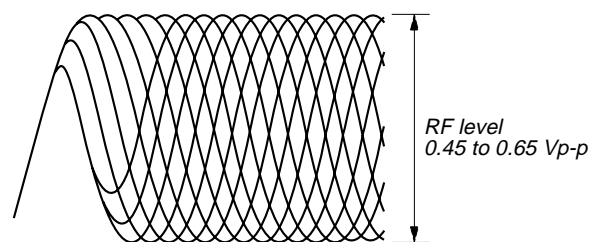


Procedure:

1. Connect the oscilloscope to the test points TP746 (RF) and TP701 (AGND) on the MAIN board.
2. Set a disc. (YEDS-18)
3. Press the button.
4. Check the oscilloscope waveform is as shown below.
A good eye pattern means that the diamond shape (◊) in the center of the waveform can be clearly distinguished.

RF Signal reference Waveform (Eye Pattern)

VOLT/DIV : 100 mV (With the 10:1 probe in use)
TIME/DIV : 500 ns



To watch the eye pattern, set the oscilloscope to AC range and increase the vertical sensitivity of the oscilloscope for easy watching.

5. Stop revolving of the disc motor by pressing the button.

SECTION 5 DIAGRAMS

NOTE FOR PRINTED WIRING BOARDS AND SCHEMATIC DIAGRAMS

Note on Printed Wiring Board

- : parts extracted from the component side.
- : parts extracted from the conductor side.
- : Pattern from the side which enables seeing.
(The other layers' patterns are not indicated.)

Caution:
 Pattern face side: Parts on the pattern face side seen from (Side B) the pattern face are indicated.
 Parts face side: Parts on the parts face side seen from (Side A) the parts face are indicated.

- MAIN board is multi-layer printed board. However, the patterns of intermediate-layer have not been included in the diagram.

Note on Schematic Diagram:

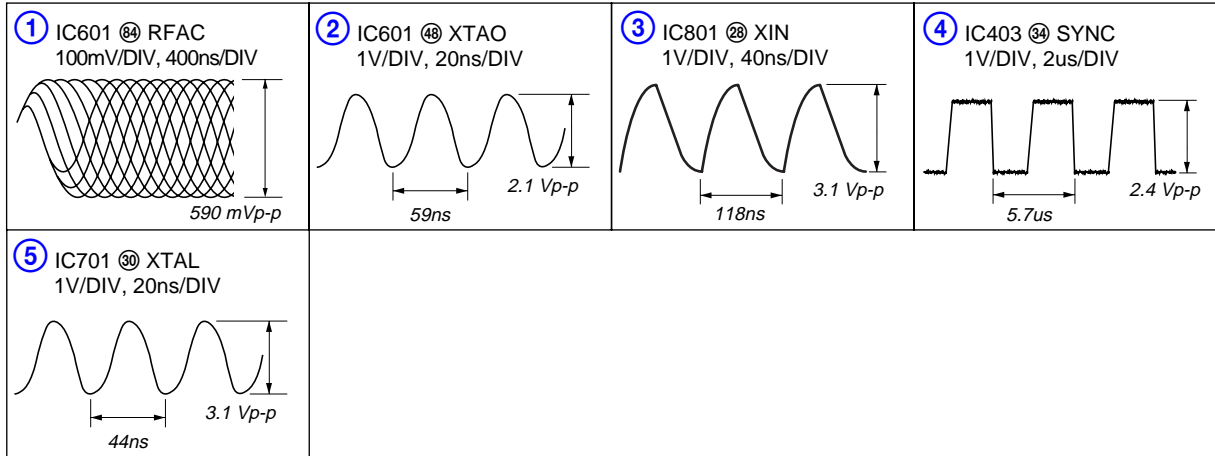
- All capacitors are in μF unless otherwise noted. pF: μF 50 WV or less are not indicated except for electrolytics and tantalums.
- All resistors are in Ω and $1/4\text{ W}$ or less unless otherwise specified.
- % : indicates tolerance.
- : panel designation.

<p>Note: The components identified by mark Δ or dotted line with mark Δ are critical for safety. Replace only with part number specified.</p>	<p>Note: Les composants identifiés par une marque Δ sont critiques pour la sécurité. Ne les remplacer que par une pièce portant le numéro spécifié.</p>
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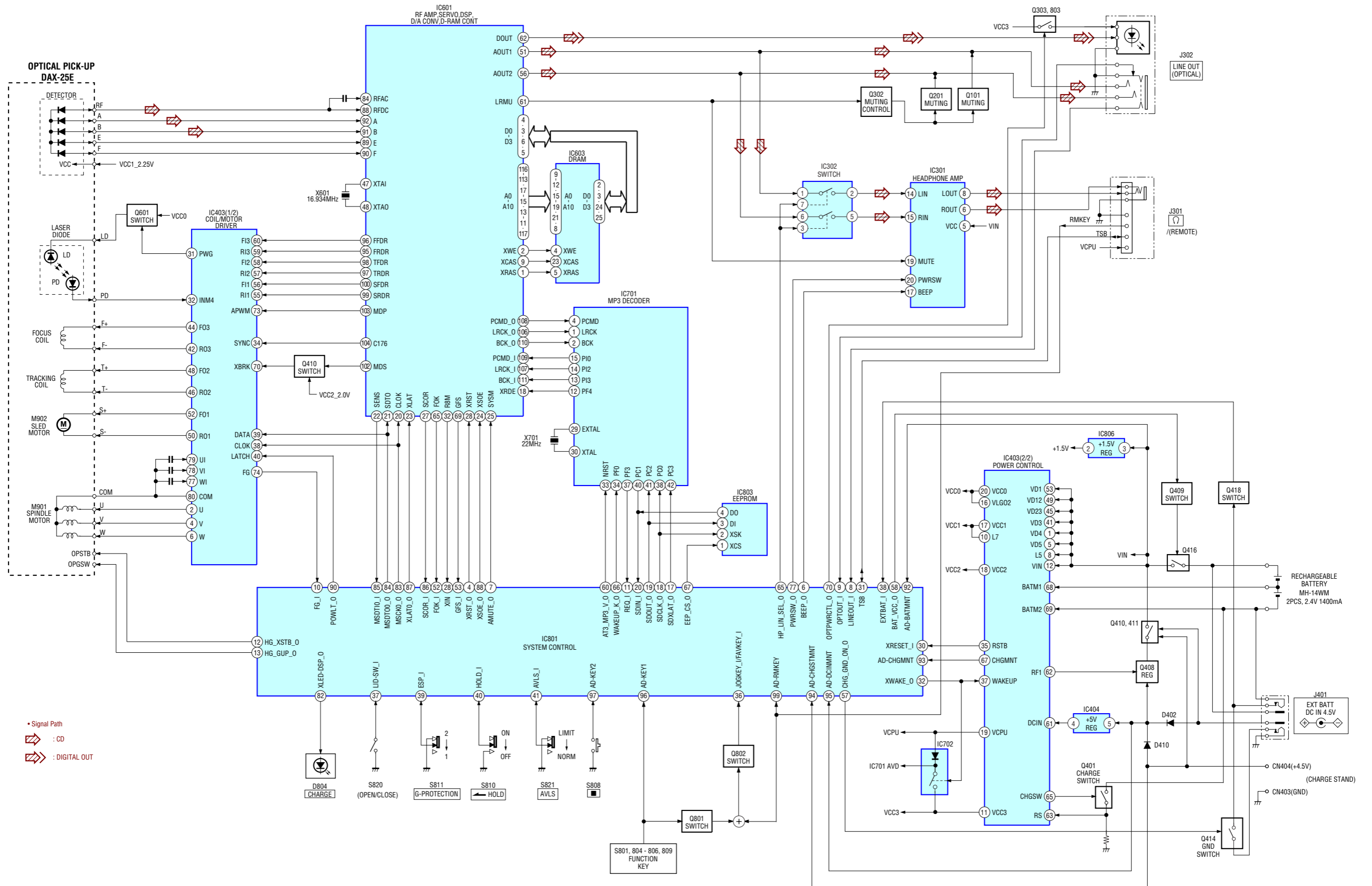
- : B+ Line.
- Total current is measured with CD installed.
- Power voltage is dc 4.5 V and fed with regulated dc power supply from DC IN jack (J401).
- Voltages and waveforms are dc with respect to ground in playback mode.
 no mark : CD PLAY
 * : Impossible to measure
- Voltages are taken with a VOM (Input impedance 10 M Ω). Voltage variations may be noted due to normal production tolerances.
- Waveforms are taken with a oscilloscope. Voltage variations may be noted due to normal production tolerances.
- Circled numbers refer to waveforms.
- Signal path.
 : CD PLAY (ANALOG OUT)
 : CD PLAY (OPTICAL OUT)

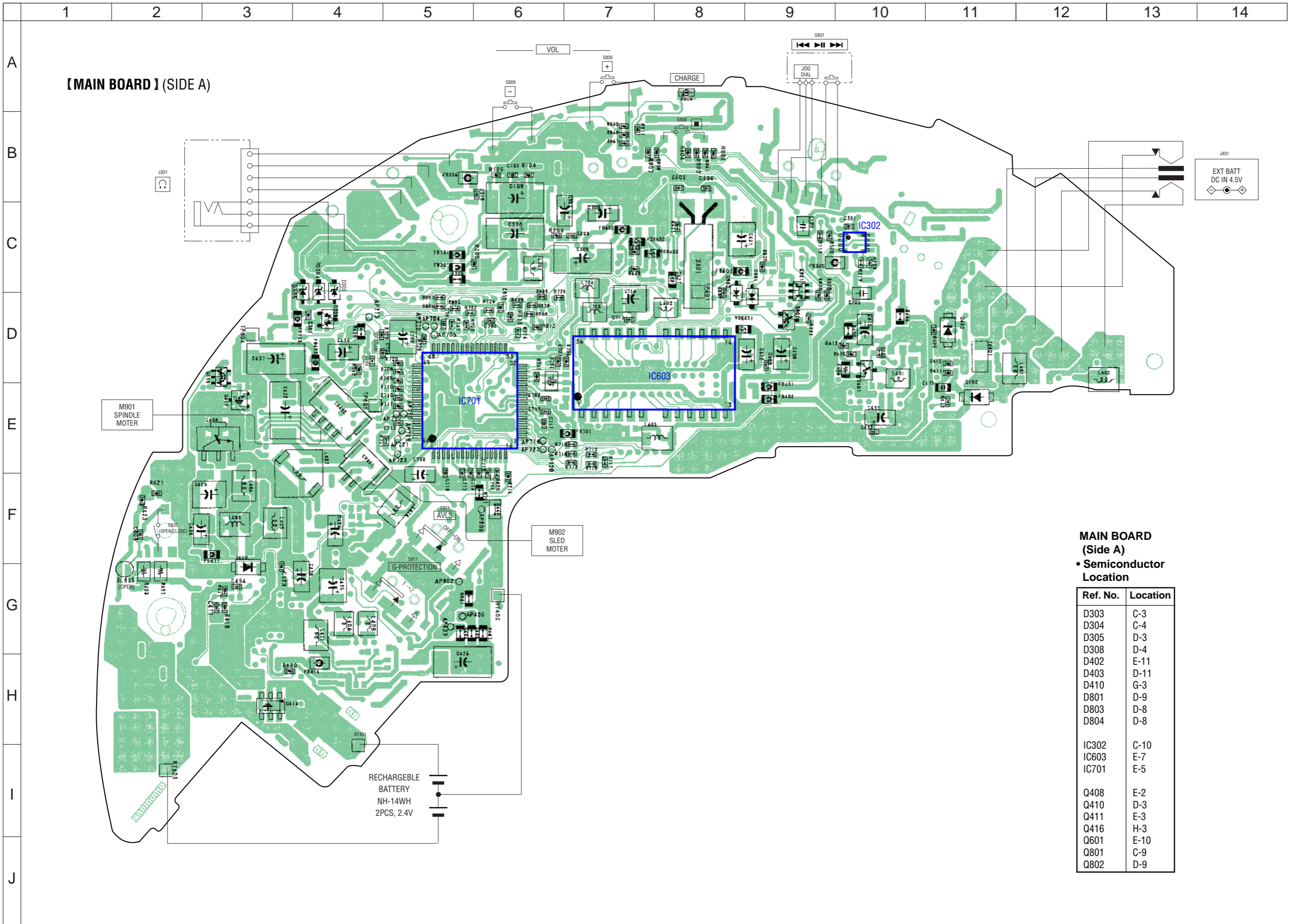
☆When IC803 is damaged, replace the MAIN board.

• WAVEFORMS



5-1. Block Diagram






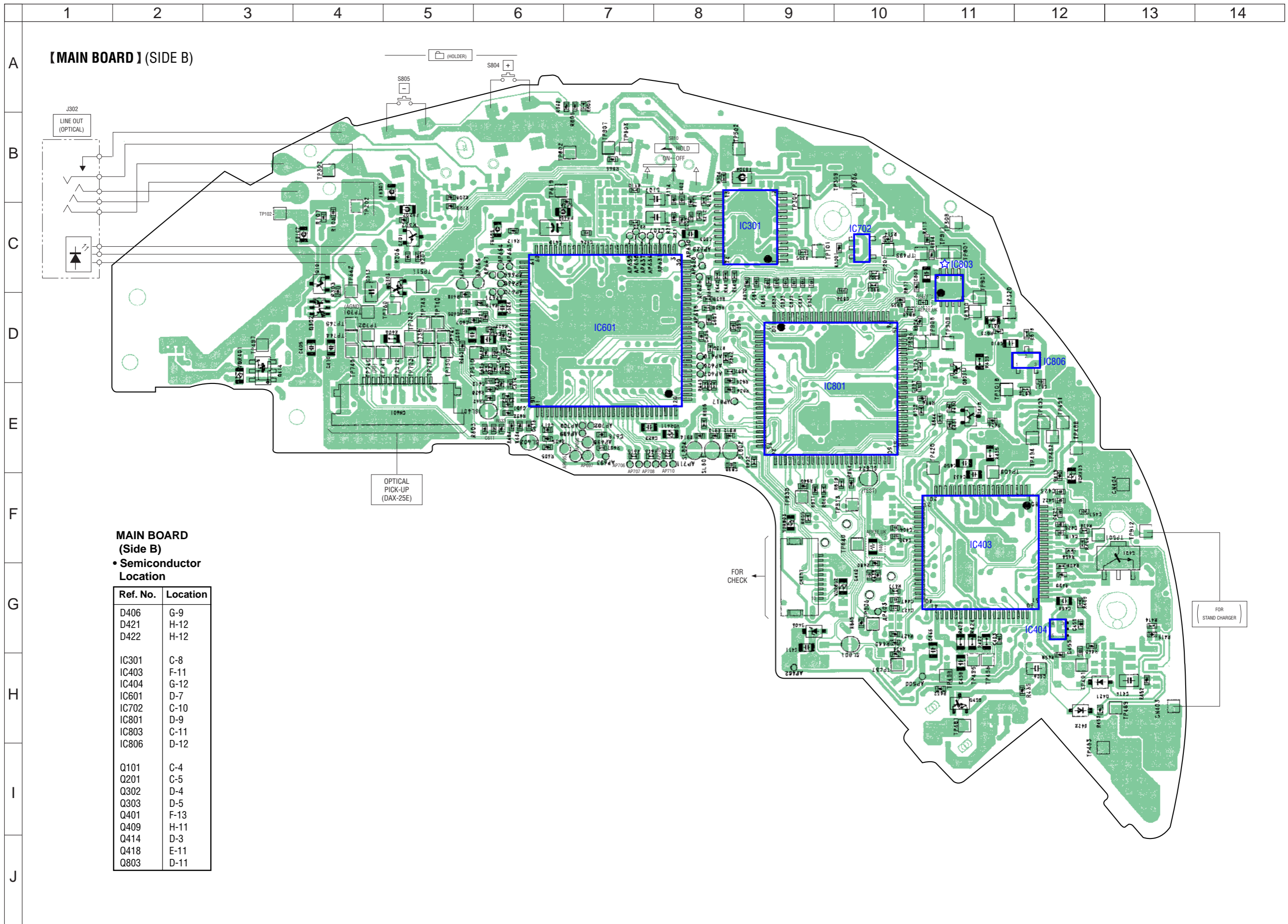
**MAIN BOARD
(Side A)
• Semiconductor
Location**

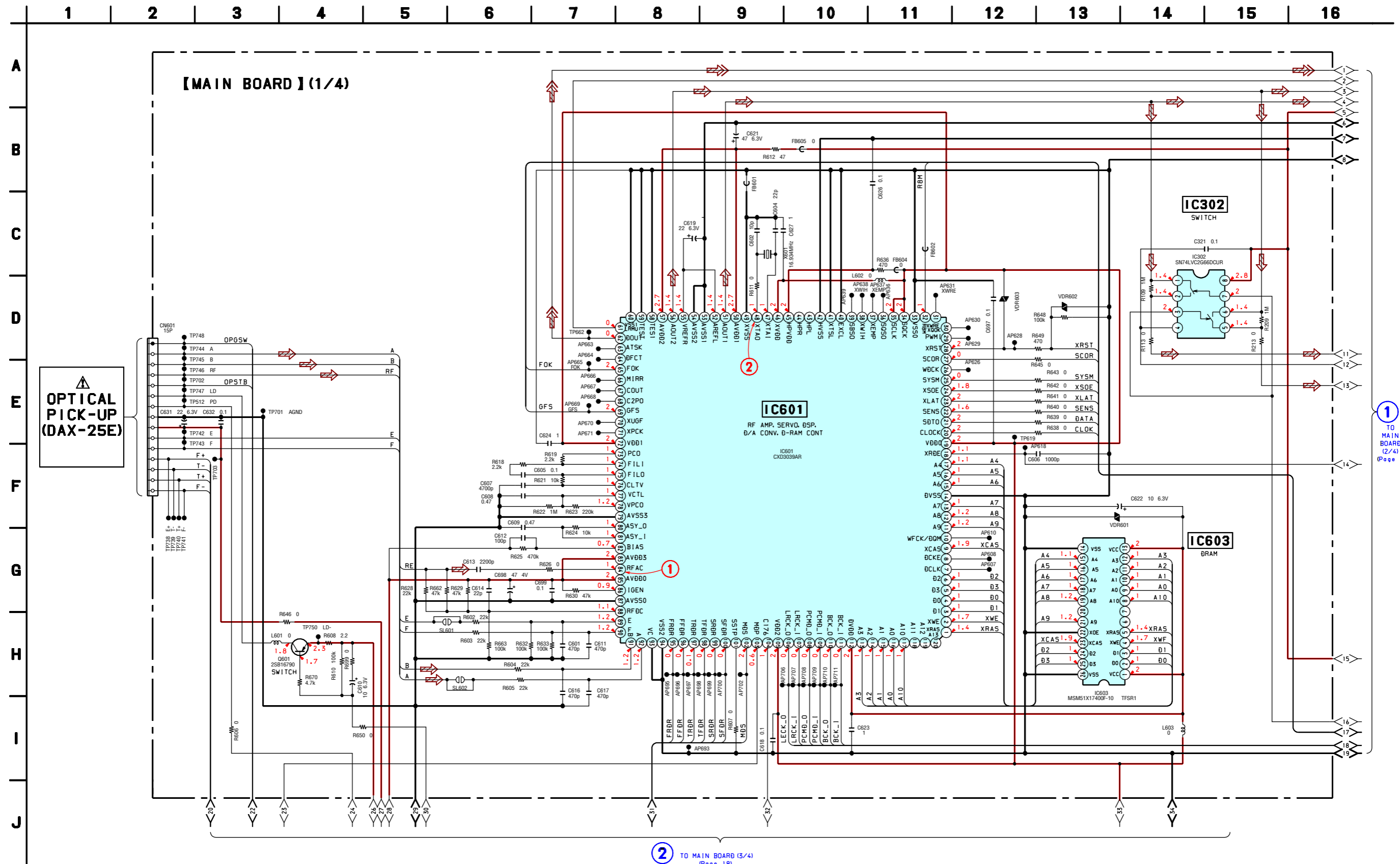
Ref. No.	Location
D303	C-3
D304	C-4
D305	D-3
D308	D-4
D402	E-11
D403	D-11
D410	G-3
D801	D-9
D803	D-8
D804	D-8
IC302	C-10
IC603	E-7
IC701	E-5
Q408	E-2
Q410	D-3
Q411	E-3
Q416	H-3
Q601	E-10
Q801	C-9
Q802	D-9

5-3. Printed Wiring Board – MAIN Board (Side B) –

•  : Uses unleaded solder.

☆When IC803 is damaged, replace the MAIN board.



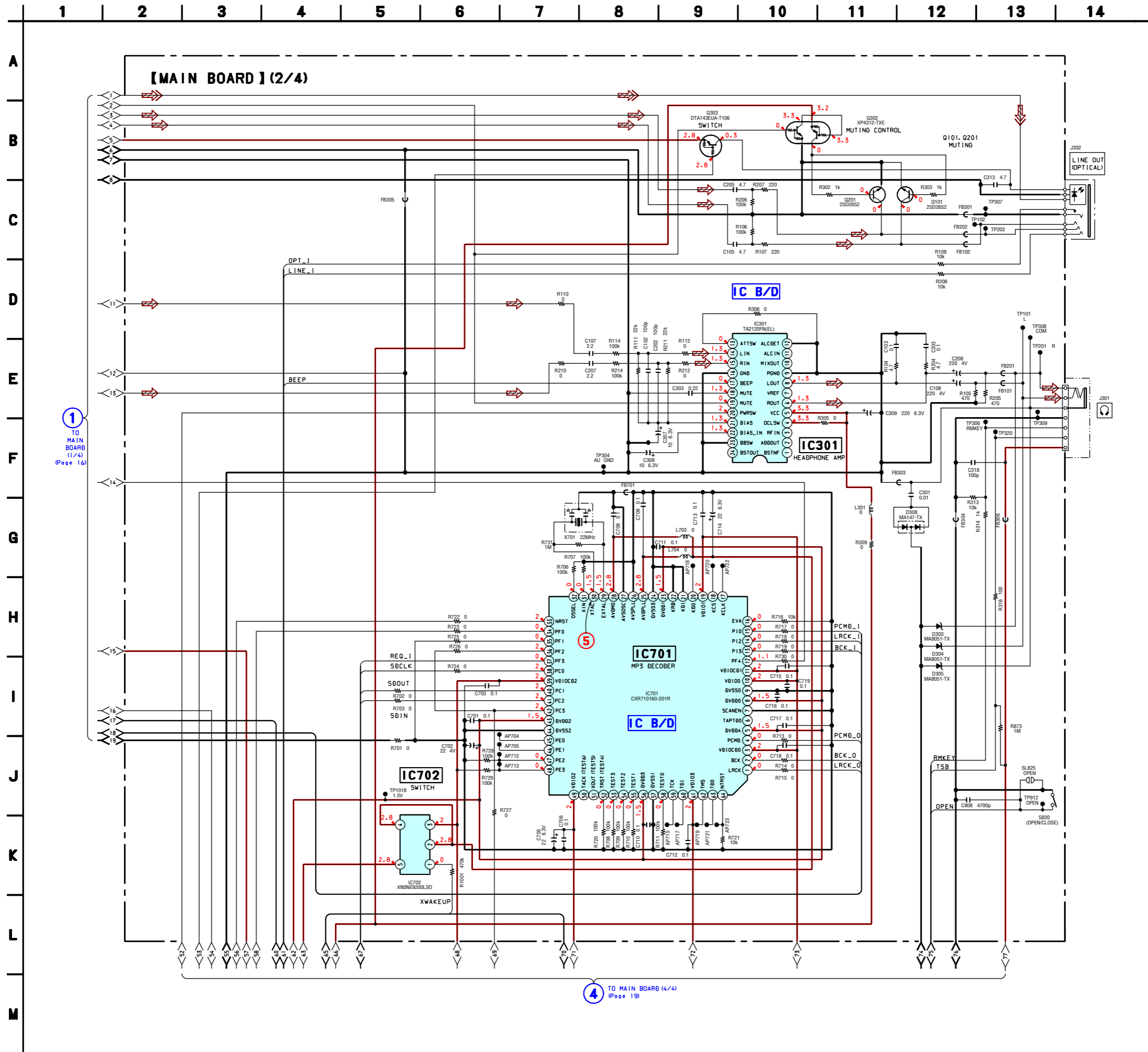


OPTICAL PICK-UP (DAX-25E)

TO MAIN BOARD (2/4) (Page 17)

TO MAIN BOARD (3/4) (Page 18)

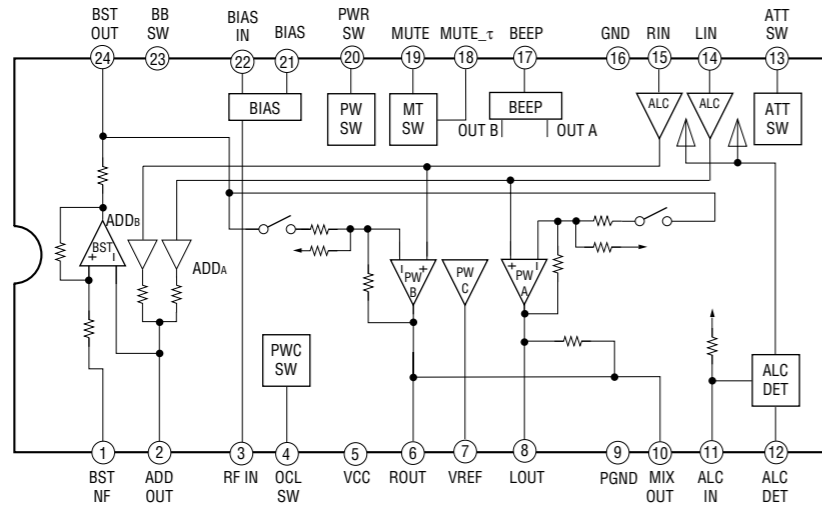
5-5. Schematic Diagrams – MAIN Board (2/4) – • See page 12 for Waveform. • See page 20 for IC Block Diagrams.



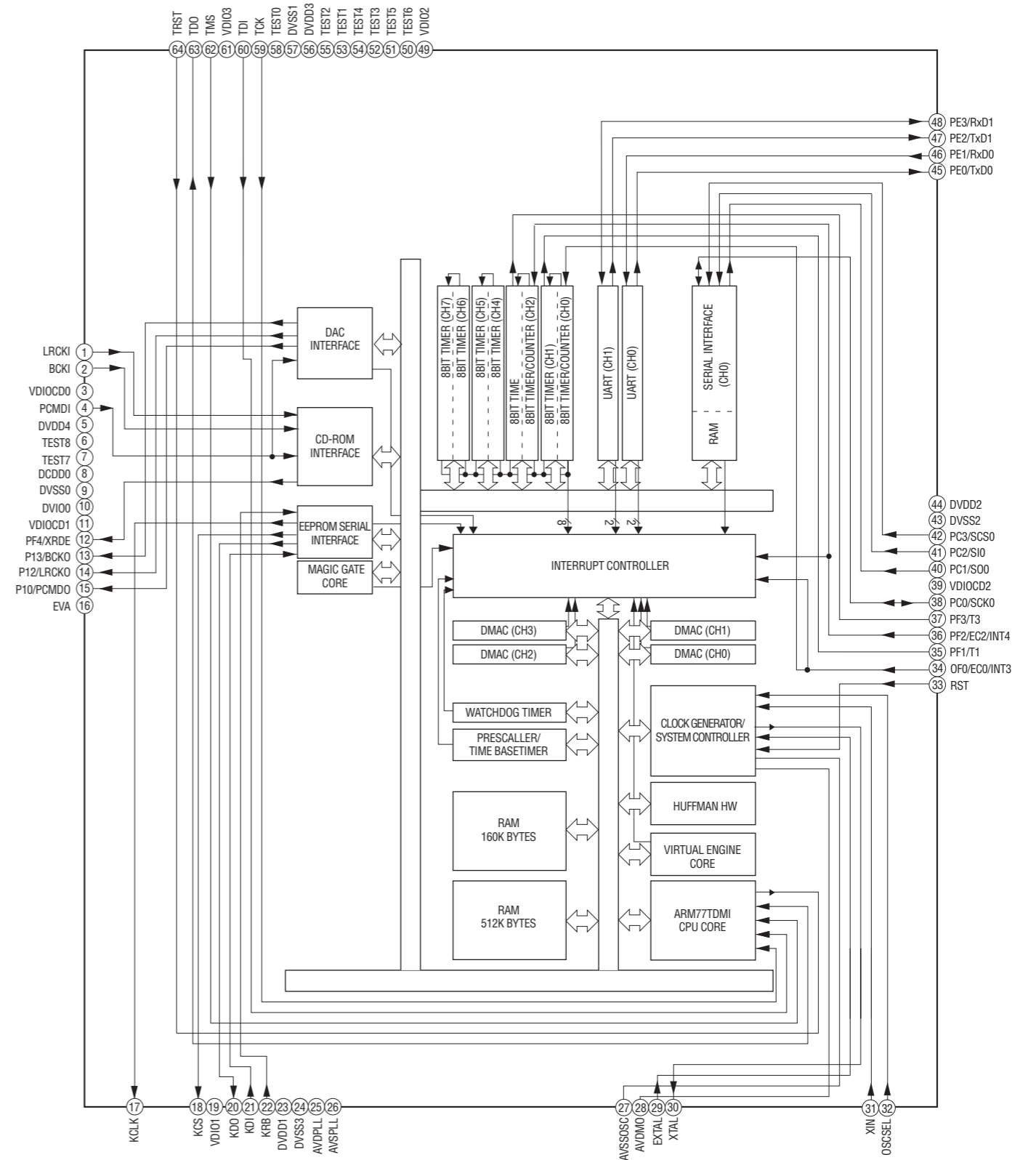
1 TO MAIN BOARD (1/4) (Page 16)

4 TO MAIN BOARD (4/4) (Page 19)

IC301 TA2120FN (EL)



IC701 CXR710160-210R



5-9. IC Pin Function Descriptions

• IC601 CXD3039AR

(RF AMP, DIGITAL SIGNAL PROCESSOR, DIGITAL SERVO PROCESSOR, D-RAM CONTROLLER)

Pin No.	Pin Name	I/O	Description
1	XRAS	O	Row address strobe signal output to the D-RAM
2	XWE	O	Data input enable signal output to the D-RAM
3 to 6	D1, D0, D3, D2	I/O	Two-way data bus with the D-RAM
7	DCLK	O	Not used
8	DCKE	O	Not used
9	XCAS	O	Column address strobe signal output to the D-RAM
10	WFCK	O	WFCK signal output terminal Not used
11 to 13	A9 to A7	O	Address signal output to the D-RAM
14	DVSS	—	Ground terminal (for D-RAM interface)
15 to 17	A6 to A4	O	Address signal output to the D-RAM
18	XRDE	I	D-RAM read enable signal input terminal Not used
19	VDD0	—	Power supply terminal (digital system)
20	CLOCK	I	Serial data transfer clock signal input from the system controller
21	SDTO	I	Serial data input from the system controller
22	SENS	O	Serial data output to the system controller
23	XLAT	I	Serial data latch pulse signal input from the system controller
24	XSOE	I	Serial data output enable signal input from the system controller
25	SYSM	I	Analog muting on/off control signal input from the system controller “H”: muting on
26	WDCK	O	GRSCOR signal output to the system controller
27	SCOR	O	Subcode sync (S0+S1) detection signal output to the system controller
28	XRST	I	Reset signal input from the system controller “L”: reset
29	PWMI	I	Spindle motor external control signal input terminal Not used
30	XQOK	I	Subcode Q OK signal input terminal Not used
31	XWRE	I	D-RAM write enable signal input terminal Not used
32	R8M	O	System clock output to the system controller
33	VSS0	—	Ground terminal (digital system)
34	SQCK	I	SQSO readout clock signal input terminal Not used
35	SCLK	I	SENS serial data read clock signal input terminal Not used
36	SQSO	O	CD text data output terminal Not used
37	XEMP	O	D-RAM read prohibition signal output terminal Not used
38	XWIH	O	D-RAM write prohibition signal output terminal Not used
39	SBSO	O	Subcode P to W serial data output terminal Not used
40	EXCK	O	SQSO readout clock signal output terminal Not used
41	XTSL	I	Input terminal for the system clock frequency setting “L”: 16.9344 MHz, “H”: 33.8688MHz (fixed at “L” in this set)
42	HVSS	—	Ground terminal (for headphone)
43	HPL	O	PDM signal output for L-ch headphone to the headphone amplifier
44	HPR	O	PDM signal output for R-ch headphone to the headphone amplifier
45	HPVDD	—	Power supply terminal (for headphone)
46	XVDD	—	Power supply terminal (for master clock)
47	XTAI	I	System clock input terminal (16.9344 MHz)
48	XTAO	O	System clock output terminal (16.9344 MHz)
49	XVSS	—	Ground terminal (for master clock)
50	AVDD1	—	Power supply terminal (analog system)
51	AOUT1	O	L-ch analog audio signal output
52	VREFL	O	L-ch reference voltage output terminal

Pin No.	Pin Name	I/O	Description
53, 54	AVSS1, AVSS2	—	Ground terminal (analog system)
55	VREFR	O	R-ch reference voltage output terminal
56	AOUT2	O	R-ch analog audio signal output
57	AVDD2	—	Power supply terminal (analog system)
58	TES1	I	Input terminal for the test (normally: fixed at “L”)
59	TEST	I	Input terminal for the test (normally: fixed at “L”)
60	VSS1	—	Ground terminal (digital system)
61	LRMU	O	Muting on/off control signal output to the audio line and the headphone amplifier “H”: muting on
62	DOUT	O	Digital audio signal output
63	ATSK	I/O	Input/output terminal for anti-shock Not used
64	DFCT	I/O	Defect signal input/output terminal Not used
65	FOK	O	Focus OK signal output to the system controller “L”: NG, “H”: OK
66	MIRR	I/O	Defect signal input/output terminal Not used
67	COUT	I/O	Numbers of track counted signal input/output terminal Not used
68	C2PO	O	C2PO signal output terminal Not used
69	GFS	O	GFS signal output terminal Not used
70	XUGF	O	XUGF signal output terminal Not used
71	XPCK	O	XPCK signal output terminal Not used
72	VDD1	—	Power supply terminal (digital system)
73	PCO	O	Charge pump output for master PLL
74	FILI	I	Filter input for master PLL
75	FILO	O	Filter output for master PLL
76	CLTV	I	VCO1 control voltage input terminal for multiplier
77	VCTL	I	VCO2 control voltage input terminal for broad-band EFM PLL
78	VPCO	O	Charge pump output terminal for broad-band EFM PLL
79	AVSS3	—	Ground terminal (analog system)
80	ASYO	O	EFM full-swing output terminal
81	ASYI	I	Asymmetry comparator voltage input terminal
82	BIAS	I	Asymmetry circuit constant current input terminal
83	AVDD3	—	Power supply terminal (analog system)
84	RFAC	I	EFM signal input from the optical pick-up
85	AVDD0	—	Power supply terminal (analog system)
86	IGEN	I	Stabilized current input for operational amplifiers
87	AVSS0	—	Ground terminal (analog system)
88	RFDC	I	RF signal input from the optical pick-up
89	E	I	E signal input from the optical pick-up
90	F	I	F signal input from the optical pick-up
91	B	I	B signal input from the optical pick-up
92	A	I	A signal input from the optical pick-up
93	VC	I	Middle point voltage input terminal Not used
94	VSS3	—	Ground terminal (digital system)
95	FRDR	O	Focus servo drive signal (–) output to the TB2130AF
96	FFDR	O	Focus servo drive signal (+) output to the TB2130AF
97	TRDR	O	Tracking servo drive signal (–) output to the TB2130AF
98	TFDR	O	Tracking servo drive signal (+) output to the TB2130AF
99	SRDR	O	Sled servo drive signal (–) output to the TB2130AF

Pin No.	Pin Name	I/O	Description
100	SFDR	O	Sled servo drive signal (+) output to the TB2130AF
101	SSTP	I	Disc inner position detection signal input terminal Not used
102	MDS	O	Spindle motor drive signal output to the spindle motor driver
103	MDP	O	Spindle motor servo control signal output to the spindle motor driver
104	C176	O	176.4 kHz clock signal output to the power control and spindle motor driver
105	VDD2	—	Power supply terminal (digital system)
106	LRCK	O	L/R sampling clock signal (44.1 kHz) output terminal
107	LRCKI	I	L/R sampling clock signal (44.1 kHz) input terminal
108	PCMD	O	Serial data output terminal
109	PCMDI	I	Serial data input terminal
110	BCKO	O	Bit clock signal (2.8224 MHz) output terminal
111	BCKI	I	Bit clock signal (2.8224 MHz) input terminal
112	DVDD	—	Power supply terminal (for D-RAM interface)
113 to 117	A3 to A0, A10	O	Address signal output to the D-RAM
118 to 120	A11 to A13	O	Address signal output terminal to the D-RAM Not used

• IC801 TMP91CW28FG-4PNO

Pin No.	Pin Name	I/O	Description
1	GND	—	Reference voltage terminal (A/D converter)
2	GND	—	Ground terminal (A/D converter)
3	VCPU	—	Power supply terminal (A/D converter)
4	XRST_O	O	Reset signal output to the DSP (IC601)
5	PWM_O	O	Not used (open)
6	BEEP_O	O	BEEP signal output
7	AMUTE_O	O	Muting signal output to the DSP (IC601)
8	LINEOUT_I	I	Line plug in detection signal input (“H” : line plug in)
9	OPTOUT_I	I	Optical plug in detection signal input (“H” : optical plug in)
10	FG_I	I	FG (3 phase drive) signal input from the power control (IC403)
11	REQ_I	I	Request signal input from the decoder (IC701)
12	HG-XSTB_O	O	HG sleep mode signal output to the optical-pickup
13	HG-GUP_O	O	HG gain up signal output to the optical-pickup
14	RE1_I	I	Not used (open)
15	RE2_I	I	Not used (open)
16	LCD_REQ_O	O	Not used (open)
17	SDXLAT_O	O	Serial data latch signal output to the decoder (IC701)
18	SDCLK_O	O	Clock output to the decoder (IC701)
19	SDOUT_O	O	Serial data output to the decoder (IC701)
20	SDIN_I	I	Serial data input from the decoder (IC701)
21	DTS_SDTO	O	Not used
22	DTS_SDTI	I	Not used
23	DTS_SCK	O	Not used
24	AM0_I	I	Not used (fixed at “H”)
25	VCPU	—	Power supply terminal
26	XOUT	O	Clock output (not used)
27	GND	—	Ground terminal
28	XIN	I	Clock input
29	AM1_I	I	Not used (fixed at “H”)
30	XRESET_I	I	Reset signal input (“L” : reset)
31	TSB	I/O	Data input/output from/to the remote control
32	XWAKE_O	O	Wake signal output to the power control (IC403) (“L” : running)
33	EMU0_O	O	Not used (open)
34	EMU1_O	O	Not used (open)
35	ACKCD_I	I	Not used (fixed at “L”)
36	JOGKEY_I/FAVKEY_I	I	Key signal input from the jog key or the remote control key
37	LID-SW_I	I	Lid open/close detection signal input (“H” : lid open)
38	EXTBAT_I	I	External battery in detection signal input (“H” : external battery in)
39	ESP_I	I	G-protection switch detection signal input (“H” : G-protection 2)
40	HOLD_I	I	HOLD switch detection signal input (“H” : HOLD on)
41	AVLS_I	I	AVLS switch detection signal input (“H” : AVLS on)
42	TEST_I	I	Test mode setting terminal (“L” : test mode)
43	NC	—	Not used (open)
44 to 51	AD0 to AD7	I/O	Not used (open)
52	FOK_I	I	FOK signal input from the DSP (IC601)
53	GFS_I	I	GFS signal input from the DSP (IC601)
54	TUPWRON_O	O	Not used (open)
55	CDON_O	O	Not used (open)
56	AUD_SEL_O	O	Not used (open)
57	CHG_GND_ON_O	O	Charge ground switch control signal output

Pin No.	Pin Name	I/O	Description
58	BAT_VCC_O	O	Battery power switch control signal output
59	DTS_RST_O	O	Not used (open)
60	AT3_MP3_V_O	O	Reset signal output to the decoder (IC701)
61	P/S_O	O	Not used (open)
62	GND	—	Ground terminal
63	XNMI_I	I	Not used (fixed at “H”)
64	VCPU	—	Power supply terminal
65	HP_LIN_SEL_O	O	Headphone or line out selection control signal output
66	WAKEUP_K_O	O	Wakeup signal output to the decoder (IC701)
67	EEP_CS_O	O	Chip select signal output to the EEPROM (IC803)
68	TUON_I	I	Not used (fixed at “H”)
69	LCD_A0	O	Not used (open)
70	OPTPWRCTL_O	O	Optical output power supply control signal output
71	XRD_O	O	Not used (open)
72	XWR_O	O	Not used (open)
73	LCD-XRST_O	O	Not used (open)
74	XLCD-BL_O	O	Not used (open)
75	DISPLAY_TYPE	I	Not used (open)
76	TUNER_TYPE	I	Tuner model setting terminal (“H” : tuner model) (fixed at “L”)
77	HP_PWRSW	O	Headphone amplifier enable signal output (“H” : enable)
78	BOOT	I	BOOT signal input
79	DRAM0_I	I	DRAM setting terminal (“H” : 4M, “L” : 16M)
80	DRAM1_I	I	Not used (fixed at “L”)
81	XCEX_I	I	Not used (open)
82	XLED-DISP_O	O	LED control signal output
83	MSCK0_O	O	Clock signal output to the DSP (IC601) and the power control (IC403)
84	MSDTO0_O	O	Serial data output to the DSP (IC601) and the power control (IC403)
85	MSDTI0_I	I	SENS signal input from the DSP (IC601)
86	SCOR_I	I	SCOR signal input from the DSP (IC601)
87	XLAT0_O	O	Latch signal output to the DSP (IC601)
88	XSOE_O	O	Serial data output enable signal output to the DSP (IC601)
89	VCPU	—	Power supply terminal
90	PWRLAT_O	O	Data latch signal output to the power control (IC403)
91	GND	—	Ground terminal
92	AD-BATMNT	I	Battery monitoring signal input
93	AD-CHGMNT	I	Charge monitoring signal input
94	AD-CHGSTMNT	I	Charge stand monitoring signal input
95	AD-DCINMNT	I	DC in monitoring signal input
96	AD-KEY1	I	Key 1 signal A/D input
97	AD-KEY2	I	Key 2 signal A/D input
98	AD-KEY3	I	Key 3 signal A/D input
99	AD-RMKEY	I	Remote control key signal A/D input
100	VCPU	—	Reference voltage terminal (A/D converter)

SECTION 6 EXPLODED VIEWS

NOTE:

- -XX, -X mean standardized parts, so they may have some differences from the original one.
- Items marked “*” are not stocked since they are seldom required for routine service. Some delay should be anticipated when ordering these items.
- The mechanical parts with no reference number in the exploded views are not supplied.
- Color Indication of Appearance Parts Example:
KNOB, BALANCE (WHITE) . . . (RED)

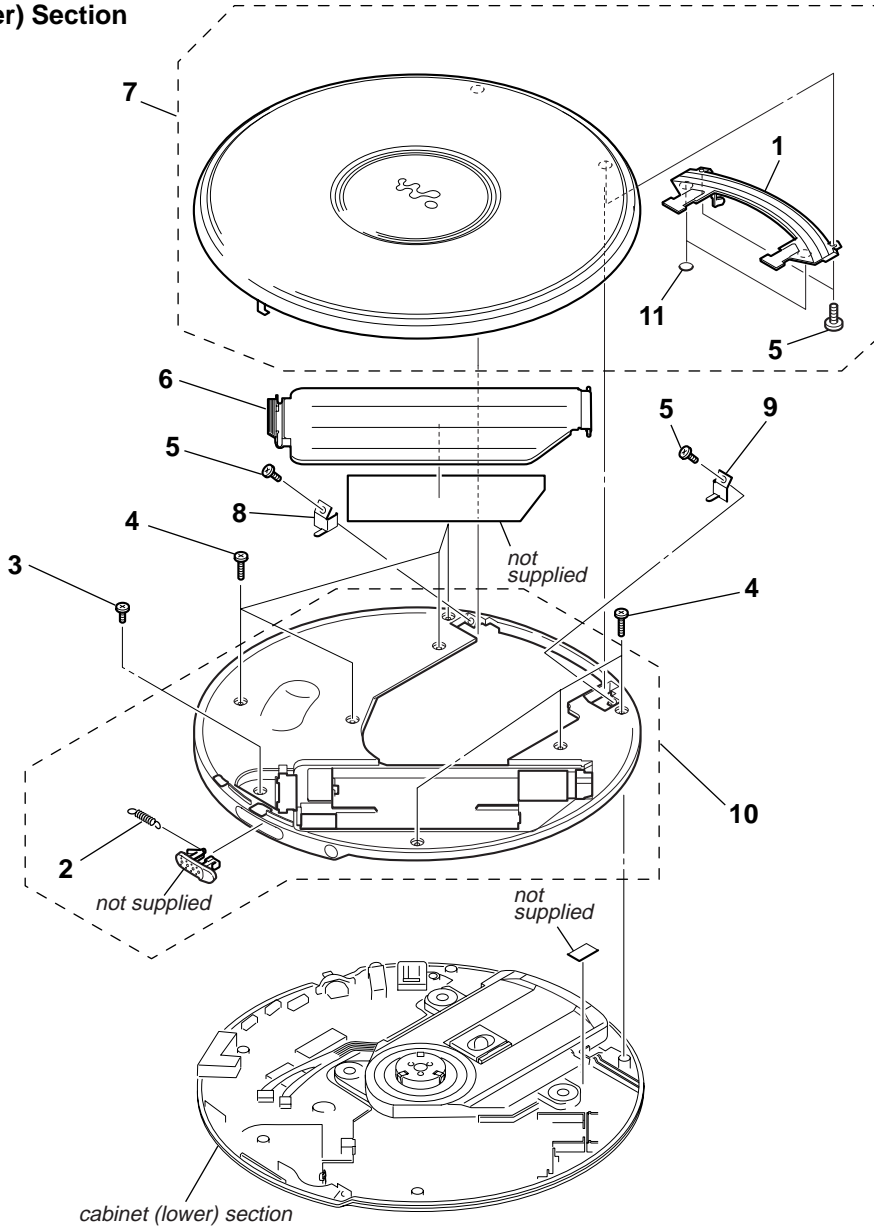
↑ ↑
Parts of Color Cabinet's Color

- Accessories are given in the last of electrical parts list.
- Abbreviation
AUS : Australian model
CND: Canadian model
CH : Chinese model
E18 : 100-230 V AC area in E model
EE : East European model
HK : Hong Kong model
JE : Tourist model
KR : Korean model
TW : Taiwan model

The components identified by mark \triangle or dotted line with mark \triangle are critical for safety. Replace only with part number specified.

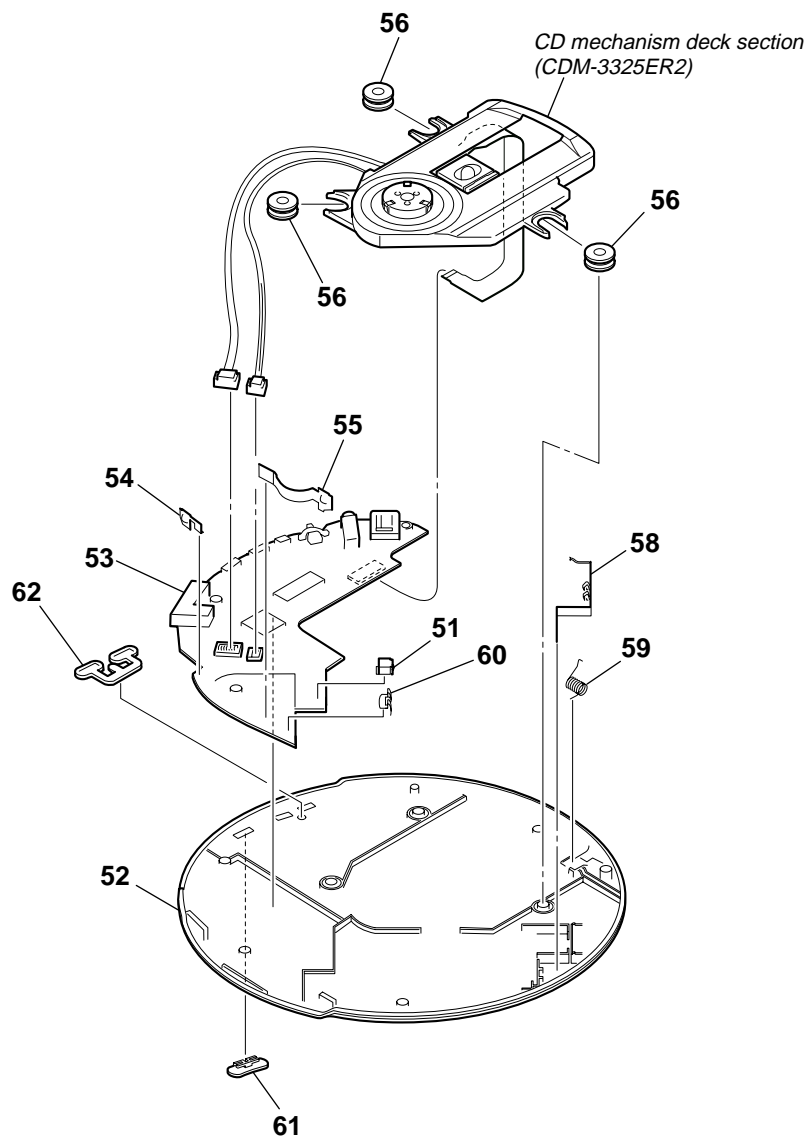
Les composants identifiés par une marque \triangle sont critiques pour la sécurité. Ne les remplacer que par une pièce portant le numéro spécifié.

6-1. Cabinet (upper) Section



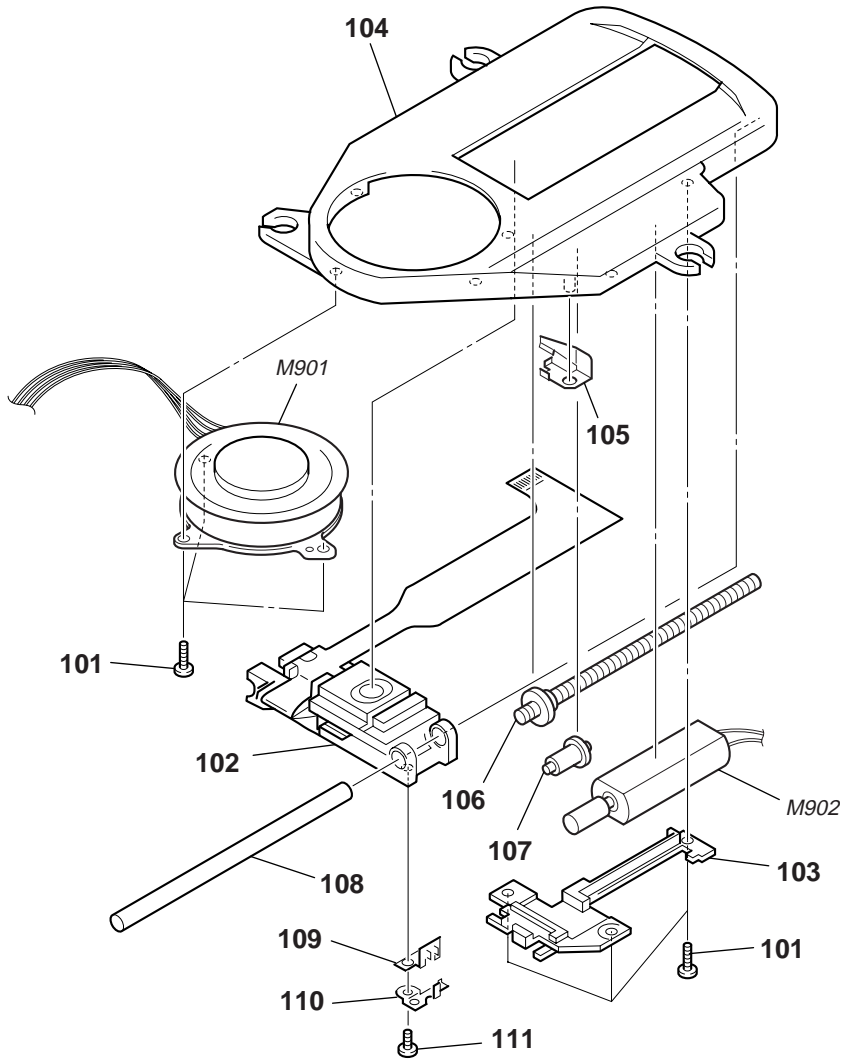
Ref. No.	Part No.	Description	Remarks	Ref. No.	Part No.	Description	Remarks
1	3-252-112-01	PLATE, FULCRUM (NE1)		7	X-3383-573-1	LID UPPER ASSY (B) (BLUE) (NE9)	
2	3-233-998-01	SPRING, TENSION		7	X-3383-811-1	LID UPPER ASSY (NE1)	
3	4-908-792-01	SCREW (B2)		8	3-245-864-01	GUIDE (L)	
4	4-908-792-61	SCREW (B2)		9	3-245-865-02	GUIDE (R)	
5	3-234-449-27	SCREW (M1.4) (NE1)		10	X-3382-570-1	CABINET (UPPER) SUB ASSY (S) (SILVER)	
6	X-3383-230-1	LID ASSY, BATTERY CASE (NE9:JE)		10	X-3383-806-1	CABINET (UPPER) SUB ASSY (ML) (BLUE)	
6	X-3383-231-1	LID ASSY, BATTERY CASE	(NE1/NE9:CND,AEP,EE,E18,AUS,CH)				(NE9)
6	X-3383-232-1	LID ASSY, BATTERY CASE (NE9:HK,KR,TW)		11	3-253-773-01	SPACER (DISC) (NE1)	
7	X-3383-572-1	LID UPPER ASSY (S) (SILVER) (NE9)					

6-2. Cabinet (lower) Section



Ref. No.	Part No.	Description	Remarks	Ref. No.	Part No.	Description	Remarks
51	3-245-312-01	BATTERY TERMINAL (+)		52	X-3383-612-1	CABINET ASSY (ML), LOWER (BLUE)	
52	X-3383-517-1	CABINET ASSY, LOWER				(NE9:AEP,EE)	
			(NE1:US,CND,UK,TW,JE)	53	X-3383-969-1	MAIN BOARD, COMPLETE	
52	X-3383-519-1	CABINET (LOWER) ASSY (NE1:HK,KR,AUS,CH)				(EXCEPT AEP,EE,UK)	
52	X-3383-520-1	CABINET (LOWER) ASSY (NE1:AEP,EE,E18)		53	X-3383-970-1	MAIN BOARD, COMPLETE (AEP,EE,UK)	
52	X-3383-598-1	CABINET ASSY (S), LOWER (SILVER)		54	3-233-988-01	TERMINAL BOARD (+), CHARGE	
			(NE9:KR,TW,JE)	55	3-245-837-01	TERMINAL BOARD (-), CHARGE	
52	X-3383-608-1	CABINET ASSY (S), LOWER (SILVER)		56	3-245-331-02	INSULATOR	
			(NE9:KR,TW,JE)	58	3-245-863-02	TERMINAL BOARD (RELAY),BATTERY	
52	X-3383-609-1	CABINET ASSY (S), LOWER (SILVER)		59	3-245-866-01	SPRING (UPPER LID) (NE1)	
			(NE9:CND,E18,HK,AUS,CH)	59	3-248-705-01	SPRING(LID UPPER-2768) (NE9)	
52	X-3383-610-1	CABINET ASSY (ML), LOWER (BLUE)		60	3-246-403-01	TERMINAL BOARD (-), BATTERY	
			(NE9:E18,HK,AUS,CH)				
52	X-3383-611-1	CABINET ASSY (S), LOWER (SILVER)		61	3-252-111-01	KNOB (HOLD)	
			(NE9:AEP,EE)	62	3-252-116-01	BUTTON (FOLDER)	

6-3. CD Mechanism Deck Section (CDM-3325ER2)



Ref. No.	Part No.	Description	Remarks	Ref. No.	Part No.	Description	Remarks
101	3-318-203-61	SCREW (B1.7X4), TAPPING		108	3-221-475-01	SHAFT, STANDARD	
△ 102	X-3380-950-1	OPTICAL PICK-UP (DAX-25E)		109	3-222-298-01	RACK	
103	3-221-473-01	COVER, GEAR		110	3-222-299-01	SPRING, RACK RETAINER	
104	3-221-472-02	CHASSIS		111	3-348-998-31	SCREW (M1.4X2.5), TAPPING, PAN	
105	3-221-474-01	SPRING, SLED		M901	A-3608-777-A	MOTOR ASSY, TURN TABLE (SPINDLE)	
106	A-3331-663-A	FEED ASSY, SCREW		M902	A-3174-850-A	MOTOR ASSY, SLED (SLED)	
107	3-221-268-01	GEAR (B)					

<p>The components identified by mark △ or dotted line with mark △ are critical for safety. Replace only with part number specified.</p>	<p>Les composants identifiés par une marque △ sont critiques pour la sécurité. Ne les remplacer que par une pièce portant le numéro spécifié.</p>
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SECTION 7 ELECTRICAL PARTS LIST

MAIN

NOTE:

- Due to standardization, replacements in the parts list may be different from the parts specified in the diagrams or the components used on the set.
- -XX, -X mean standardized parts, so they may have some difference from the original one.
- Items marked "*" are not stocked since they are seldom required for routine service. Some delay should be anticipated when ordering these items.
- CAPACITORS:
uF: μ F

- RESISTORS
All resistors are in ohms.
METAL: metal-film resistor
METAL OXIDE: Metal Oxide-film resistor
F: nonflammable
- COILS
uH: μ H
- Abbreviation
AUS : Australian model
CND: Canadian model
CH : Chinese model
E18 : 100-230 V AC area in E model
HK : Hong Kong model
JE : Tourist model
KR : Korean model
TW : Taiwan model

- SEMICONDUCTORS
In each case, u: μ , for example:
uA...: μ A..., uPA..., μ PA...,
uPB..., μ PB..., uPC..., μ PC...,
uPD..., μ PD...

When indicating parts by reference number, please include the board name.

The components identified by mark Δ or dotted line with mark Δ are critical for safety. Replace only with part number specified.

Les composants identifiés par une marque Δ sont critiques pour la sécurité. Ne les remplacer que par une pièce portant le numéro spécifié.

Ref. No.	Part No.	Description	Remarks	Ref. No.	Part No.	Description	Remarks
	X-3383-969-1	MAIN BOARD, COMPLETE	(EXCEPT AEP,EE,UK)	C430	1-164-939-11	CERAMIC CHIP	0.0022uF 10.00% 50V
		*****		C432	1-128-829-91	TANTAL. CHIP	220uF 20% 6.3V
	X-3383-970-1	MAIN BOARD, COMPLETE (AEP,EE,UK)	*****	C433	1-115-156-11	CERAMIC CHIP	1uF 10V
		< CAPACITOR >		C434	1-165-851-91	TANTAL. CHIP	10uF 20% 6.3V
				C435	1-110-569-11	TANTAL. CHIP	47uF 20.00% 6.3V
				C436	1-135-259-11	TANTAL. CHIP	10uF 20.00% 6.3V
				C437	1-128-829-91	TANTAL. CHIP	220uF 20% 6.3V
C102	1-164-874-11	CERAMIC CHIP	100PF 5.00% 50V	C438	1-125-837-91	CERAMIC CHIP	1uF 10% 6.3V
C103	1-107-820-11	CERAMIC CHIP	0.1uF 16V	C440	1-164-939-11	CERAMIC CHIP	0.0022uF 10.00% 50V
C105	1-127-760-11	CERAMIC CHIP	4.7uF 10% 6.3V	C445	1-125-837-91	CERAMIC CHIP	1uF 10% 6.3V
C107	1-125-838-11	CERAMIC CHIP	2.2uF 10% 6.3V	C447	1-164-937-11	CERAMIC CHIP	0.001uF 10.00% 50V
C108	1-125-899-11	TANTAL. CHIP	220uF 20.00% 4V	C450	1-115-156-11	CERAMIC CHIP	1uF 10V
C202	1-164-874-11	CERAMIC CHIP	100PF 5.00% 50V	C454	1-164-941-11	CERAMIC CHIP	0.0047uF 10.00% 16V
C203	1-107-820-11	CERAMIC CHIP	0.1uF 16V	C455	1-164-858-11	CERAMIC CHIP	22PF 5.00% 50V
C205	1-127-760-11	CERAMIC CHIP	4.7uF 10% 6.3V	C457	1-164-941-11	CERAMIC CHIP	0.0047uF 10.00% 16V
C207	1-125-838-11	CERAMIC CHIP	2.2uF 10% 6.3V	C458	1-125-837-91	CERAMIC CHIP	1uF 10% 6.3V
C208	1-125-899-11	TANTAL. CHIP	220uF 20.00% 4V	C459	1-164-943-11	CERAMIC CHIP	0.01uF 10.00% 16V
C301	1-164-947-11	CERAMIC CHIP	0.01uF 50V	C601	1-164-935-11	CERAMIC CHIP	470PF 10.00% 50V
C303	1-115-467-11	CERAMIC CHIP	0.22uF 10.00% 10V	C602	1-164-850-11	CERAMIC CHIP	10PF 0.50PF 50V
C307	1-135-259-11	TANTAL. CHIP	10uF 20.00% 6.3V	C604	1-164-858-11	CERAMIC CHIP	22PF 5.00% 50V
C308	1-135-259-11	TANTAL. CHIP	10uF 20.00% 6.3V	C605	1-125-777-11	CERAMIC CHIP	0.1uF 10.00% 10V
C309	1-128-829-91	TANTAL. CHIP	220uF 20% 6.3V	C606	1-164-937-11	CERAMIC CHIP	0.001uF 10.00% 50V
C313	1-117-720-11	CERAMIC CHIP	4.7uF 10V	C607	1-164-941-11	CERAMIC CHIP	0.0047uF 10.00% 16V
C318	1-164-874-11	CERAMIC CHIP	100PF 5.00% 50V	C608	1-117-863-11	CERAMIC CHIP	0.47uF 10.00% 6.3V
C321	1-107-820-11	CERAMIC CHIP	0.1uF 16V	C609	1-117-863-11	CERAMIC CHIP	0.47uF 10.00% 6.3V
C403	1-164-935-11	CERAMIC CHIP	470PF 10.00% 50V	C610	1-135-259-11	TANTAL. CHIP	10uF 20.00% 6.3V
C404	1-107-820-11	CERAMIC CHIP	0.1uF 16V	C611	1-164-935-11	CERAMIC CHIP	470PF 10.00% 50V
C405	1-115-156-11	CERAMIC CHIP	1uF 10V	C612	1-164-874-11	CERAMIC CHIP	100PF 5.00% 50V
C406	1-164-505-11	CERAMIC CHIP	2.2uF 16V	C613	1-164-939-11	CERAMIC CHIP	0.0022uF 10.00% 50V
C410	1-115-156-11	CERAMIC CHIP	1uF 10V	C614	1-164-858-11	CERAMIC CHIP	22PF 5.00% 50V
C411	1-115-156-11	CERAMIC CHIP	1uF 10V	C616	1-164-935-11	CERAMIC CHIP	470PF 10.00% 50V
C415	1-115-467-11	CERAMIC CHIP	0.22uF 10.00% 10V	C617	1-164-935-11	CERAMIC CHIP	470PF 10.00% 50V
C416	1-127-760-11	CERAMIC CHIP	4.7uF 10% 6.3V	C618	1-125-777-11	CERAMIC CHIP	0.1uF 10.00% 10V
C417	1-107-820-11	CERAMIC CHIP	0.1uF 16V	C619	1-119-750-11	TANTAL. CHIP	22uF 20.00% 6.3V
C419	1-125-777-11	CERAMIC CHIP	0.1uF 10.00% 10V	C621	1-110-569-11	TANTAL. CHIP	47uF 20.00% 6.3V
C420	1-125-777-11	CERAMIC CHIP	0.1uF 10.00% 10V	C622	1-135-259-11	TANTAL. CHIP	10uF 20.00% 6.3V
C421	1-164-937-11	CERAMIC CHIP	0.001uF 10.00% 50V	C623	1-125-837-91	CERAMIC CHIP	1uF 10% 6.3V
C422	1-164-937-11	CERAMIC CHIP	0.001uF 10.00% 50V	C624	1-115-156-11	CERAMIC CHIP	1uF 10V
C423	1-164-937-11	CERAMIC CHIP	0.001uF 10.00% 50V	C626	1-107-820-11	CERAMIC CHIP	0.1uF 16V
C424	1-135-210-11	TANTALUM CHIP	4.7uF 20% 10V	C627	1-115-156-11	CERAMIC CHIP	1uF 10V
C425	1-110-569-11	TANTAL. CHIP	47uF 20.00% 6.3V	C631	1-119-750-11	TANTAL. CHIP	22uF 20.00% 6.3V
C426	1-128-829-91	TANTAL. CHIP	220uF 20% 6.3V	C632	1-107-820-11	CERAMIC CHIP	0.1uF 16V
C427	1-125-777-11	CERAMIC CHIP	0.1uF 10.00% 10V	C697	1-107-820-11	CERAMIC CHIP	0.1uF 16V
C428	1-107-686-11	TANTAL. CHIP	4.7uF 20.00% 16V	C698	1-131-862-91	TANTAL. CHIP	47uF 20% 4V
C429	1-107-820-11	CERAMIC CHIP	0.1uF 16V	C699	1-107-820-11	CERAMIC CHIP	0.1uF 16V

MAIN

Ref. No.	Part No.	Description	Remarks	Ref. No.	Part No.	Description	Remarks
C701	1-107-820-11	CERAMIC CHIP 0.1uF	16V	FB301	1-500-234-22	FERRITE 0uH	
C702	1-104-847-11	TANTAL. CHIP 22uF	20.00% 4V	FB303	1-500-234-22	FERRITE 0uH	
C703	1-107-820-11	CERAMIC CHIP 0.1uF	16V	FB304	1-414-813-21	FERRITE 0uH	
C705	1-104-852-11	TANTAL. CHIP 22uF	20.00% 6.3V	FB305	1-414-813-21	FERRITE 0uH	
C706	1-107-820-11	CERAMIC CHIP 0.1uF	16V	FB306	1-414-813-21	FERRITE 0uH	
C708	1-107-820-11	CERAMIC CHIP 0.1uF	16V	FB401	1-414-760-21	FERRITE 0uH	
C709	1-107-820-11	CERAMIC CHIP 0.1uF	16V	FB402	1-414-760-21	FERRITE 0uH	
C710	1-107-820-11	CERAMIC CHIP 0.1uF	16V	FB403	1-414-760-21	FERRITE 0uH	
C711	1-107-820-11	CERAMIC CHIP 0.1uF	16V	FB411	1-414-760-21	FERRITE 0uH	
C712	1-107-820-11	CERAMIC CHIP 0.1uF	16V	FB415	1-216-295-91	SHORT CHIP 0	
C713	1-107-820-11	CERAMIC CHIP 0.1uF	16V	FB601	1-414-760-21	FERRITE 0uH	
C714	1-104-852-11	TANTAL. CHIP 22uF	20.00% 6.3V	FB602	1-414-760-21	FERRITE 0uH	
C715	1-107-820-11	CERAMIC CHIP 0.1uF	16V	FB604	1-216-864-91	SHORT CHIP 0	
C716	1-107-820-11	CERAMIC CHIP 0.1uF	16V	FB605	1-216-864-91	SHORT CHIP 0	
C717	1-107-820-11	CERAMIC CHIP 0.1uF	16V	FB701	1-414-760-21	FERRITE 0uH	
C718	1-107-820-11	CERAMIC CHIP 0.1uF	16V				
C719	1-107-820-11	CERAMIC CHIP 0.1uF	16V			< IC >	
C805	1-115-156-11	CERAMIC CHIP 1uF	10V	IC301	8-759-522-87	IC TA2120FN(EL)	
C808	1-164-941-11	CERAMIC CHIP 0.0047uF	10.00% 16V	* IC302	6-703-107-01	IC SN74LVC2G66DCUR	
C810	1-125-837-91	CERAMIC CHIP 1uF	10% 6.3V	IC403	6-703-902-01	IC TB2138FG	
C811	1-164-937-11	CERAMIC CHIP 0.001uF	10.00% 50V	IC404	6-704-186-01	IC TAR5S50U(TE85R)	
C812	1-107-820-11	CERAMIC CHIP 0.1uF	16V	IC601	8-752-420-71	IC CXD3039AR	
C821	1-107-820-11	CERAMIC CHIP 0.1uF	16V	IC603	6-702-737-01	IC MSM51X17400F-10TFSR1	
C830	1-164-941-11	CERAMIC CHIP 0.0047uF	10.00% 16V	IC701	8-752-935-69	IC CXR710160-201R	
C831	1-164-941-11	CERAMIC CHIP 0.0047uF	10.00% 16V	IC702	6-550-559-01	TRANSISTOR XNONE9200LSO	
C832	1-164-941-11	CERAMIC CHIP 0.0047uF	10.00% 16V	IC801	6-802-813-01	IC TMP91CW28FG-4PNO	
C833	1-164-941-11	CERAMIC CHIP 0.0047uF	10.00% 16V	☆ IC803	-----	IC AK6417CH-E2 (not supplied)	
C834	1-164-941-11	CERAMIC CHIP 0.0047uF	10.00% 16V	IC806	6-703-916-01	IC XC6206P152MR	
C835	1-164-941-11	CERAMIC CHIP 0.0047uF	10.00% 16V			< JACK >	
C896	1-107-820-11	CERAMIC CHIP 0.1uF	16V	J301	1-815-088-61	JACK, HEADPHONE (Ω)	
C897	1-107-820-11	CERAMIC CHIP 0.1uF	16V	J302	1-816-884-11	JACK, OPTICAL OUT (LINE OUT (OPTICAL))	
C898	1-107-820-11	CERAMIC CHIP 0.1uF	16V	J401	1-793-156-31	JACK, DC	
C899	1-107-820-11	CERAMIC CHIP 0.1uF	16V			< COIL >	
		< CONNECTOR >		L301	1-400-389-21	INDUCTOR 0uH	
CN401	1-784-342-21	HOUSING, CONNECTOR 2P		L401	1-400-373-21	INDUCTOR 4.7uH	
* CN402	1-785-877-21	HOUSING, CONNECTOR 4P		L402	1-400-373-21	INDUCTOR 4.7uH	
CN601	1-573-924-11	CONNECTOR, FFC/FPC (ZIF) 15P		L403	1-400-387-21	INDUCTOR 0uH	
		< DIODE >		L404	1-400-388-21	INDUCTOR 0uH	
D303	8-719-422-37	DIODE MA8051-TX		L406	1-400-390-21	INDUCTOR 0uH	
D304	8-719-422-37	DIODE MA8051-TX		L407	1-456-178-21	INDUCTOR 100uH	
D305	8-719-422-37	DIODE MA8051-TX		L408	1-400-387-21	INDUCTOR 0uH	
D308	8-719-421-33	DIODE MA147-TX		L409	1-400-390-21	INDUCTOR 0uH	
D402	8-719-081-34	DIODE RB160M-30TR		L411	1-400-387-21	INDUCTOR 0uH	
D403	8-719-081-34	DIODE RB160M-30TR		L601	1-400-389-21	INDUCTOR 0uH	
D406	8-719-422-37	DIODE MA8051-TX		L602	1-400-390-21	INDUCTOR 0uH	
D410	8-719-081-34	DIODE RB160M-30TR		L603	1-400-386-21	INDUCTOR 0uH	
D421	8-719-404-50	DIODE MA111-TX		L703	1-400-390-21	INDUCTOR 0uH	
D422	8-719-404-50	DIODE MA111-TX		L704	1-400-390-21	INDUCTOR 0uH	
D801	8-719-421-27	DIODE MA728-TX				< TRANSISTOR >	
D803	8-719-421-27	DIODE MA728-TX		Q101	6-550-364-01	TRANSISTOR 2SD2652	
D804	8-719-064-07	DIODE SML-310LTT86 (CHARGE)		Q201	6-550-364-01	TRANSISTOR 2SD2652	
		< FERRITE BEAD >		Q302	8-729-429-50	TRANSISTOR XP4312-TXE	
FB101	1-500-234-22	FERRITE 0uH		Q303	8-729-028-86	TRANSISTOR DTA143EUA-T106	
FB102	1-500-234-22	FERRITE 0uH		Q401	8-729-921-73	TRANSISTOR 2SD1781K-T146-QR	
FB201	1-500-234-22	FERRITE 0uH		Q408	8-729-920-83	TRANSISTOR 2SB1188	
FB202	1-500-234-22	FERRITE 0uH		Q409	8-729-230-63	TRANSISTOR 2SD1819A-QRS-TX	

☆ When IC803 is damaged, replace the MAIN board.

Ref. No.	Part No.	Description	Remarks	Ref. No.	Part No.	Description	Remarks
Q410	8-729-426-24	TRANSISTOR	XP1211-TXE	R425	1-216-864-11	METAL CHIP	0 5% 1/16W
Q411	8-729-055-99	TRANSISTOR	MCH3309	R426	1-218-985-11	RES-CHIP	470K 5% 1/16W
Q414	6-550-355-01	TRANSISTOR	RTQ045N03TR				
Q416	6-550-354-01	TRANSISTOR	RTQ035P02TR	R427	1-218-977-11	RES-CHIP	100K 5% 1/16W
Q418	8-729-026-53	TRANSISTOR	2SA1576A-T106-QR	R429	1-216-864-11	METAL CHIP	0 5% 1/16W
Q601	8-729-054-79	TRANSISTOR	2SB16790	R430	1-218-985-11	RES-CHIP	470K 5% 1/16W
Q801	8-729-427-72	TRANSISTOR	XP4501-TXE	R431	1-218-989-11	RES-CHIP	1M 5% 1/16W
Q802	8-729-029-10	TRANSISTOR	DTC143TUA-T106	R432	1-218-977-11	RES-CHIP	100K 5% 1/16W
Q803	8-729-929-02	TRANSISTOR	DTC124XE-TL				
		< RESISTOR >					
R104	1-220-803-81	RES-CHIP	4.7 5% 1/16W				
R105	1-218-949-11	RES-CHIP	470 5% 1/16W	R452	1-208-943-11	METAL CHIP	220K 0.5% 1/16W
R106	1-218-977-11	RES-CHIP	100K 5% 1/16W	R453	1-218-989-11	RES-CHIP	1M 5% 1/16W
R107	1-218-945-11	RES-CHIP	220 5% 1/16W	R454	1-218-990-11	SHORT CHIP	0
R108	1-218-965-11	RES-CHIP	10K 5% 1/16W	R456	1-218-990-11	SHORT CHIP	0
				R459	1-218-981-11	RES-CHIP	220K 5% 1/16W
R109	1-218-989-11	RES-CHIP	1M 5% 1/16W				
R110	1-218-990-11	SHORT CHIP	0	R460	1-218-941-81	RES-CHIP	100 5% 1/16W
R111	1-218-969-11	RES-CHIP	22K 5% 1/16W	R467	1-216-789-11	METAL CHIP	2.2 5% 1/16W
R112	1-218-990-11	SHORT CHIP	0				(AEP,EE,UK)
R113	1-218-990-11	SHORT CHIP	0	R476	1-218-990-11	SHORT CHIP	0
				R477	1-218-990-11	SHORT CHIP	0
R114	1-218-977-11	RES-CHIP	100K 5% 1/16W	R480	1-218-989-11	RES-CHIP	1M 5% 1/16W
R204	1-220-803-81	RES-CHIP	4.7 5% 1/16W				
R205	1-218-949-11	RES-CHIP	470 5% 1/16W	R485	1-216-864-11	METAL CHIP	0 5% 1/16W
R206	1-218-977-11	RES-CHIP	100K 5% 1/16W	R486	1-216-864-11	METAL CHIP	0 5% 1/16W
R207	1-218-945-11	RES-CHIP	220 5% 1/16W	R487	1-216-864-11	METAL CHIP	0 5% 1/16W
				R489	1-218-990-11	SHORT CHIP	0
R208	1-218-965-11	RES-CHIP	10K 5% 1/16W	R495	1-216-864-11	METAL CHIP	0 5% 1/16W
R209	1-218-989-11	RES-CHIP	1M 5% 1/16W				
R210	1-218-990-11	SHORT CHIP	0	R498	1-216-864-11	METAL CHIP	0 5% 1/16W
R211	1-218-969-11	RES-CHIP	22K 5% 1/16W	R499	1-218-941-81	RES-CHIP	100 5% 1/16W
R212	1-218-990-11	SHORT CHIP	0	R602	1-218-969-11	RES-CHIP	22K 5% 1/16W
				R603	1-218-969-11	RES-CHIP	22K 5% 1/16W
R213	1-218-990-11	SHORT CHIP	0	R604	1-218-969-11	RES-CHIP	22K 5% 1/16W
R214	1-218-977-11	RES-CHIP	100K 5% 1/16W				
R302	1-218-953-11	RES-CHIP	1K 5% 1/16W	R605	1-218-969-11	RES-CHIP	22K 5% 1/16W
R303	1-218-953-11	RES-CHIP	1K 5% 1/16W	R606	1-216-864-11	METAL CHIP	0 5% 1/16W
R305	1-218-990-11	SHORT CHIP	0	R607	1-218-990-11	SHORT CHIP	0
				R608	1-216-789-11	METAL CHIP	2.2 5% 1/16W
R306	1-218-990-11	SHORT CHIP	0	R610	1-218-977-11	RES-CHIP	100K 5% 1/16W
R309	1-216-864-11	METAL CHIP	0 5% 1/16W				
R313	1-208-707-11	METAL CHIP	10K 0.5% 1/16W	R611	1-218-990-11	SHORT CHIP	0
R314	1-218-953-11	RES-CHIP	1K 5% 1/16W	R612	1-218-937-11	RES-CHIP	47 5% 1/16W
R315	1-216-864-11	METAL CHIP	0 5% 1/16W	R618	1-218-957-11	RES-CHIP	2.2K 5% 1/16W
				R619	1-218-957-11	RES-CHIP	2.2K 5% 1/16W
R316	1-218-941-81	RES-CHIP	100 5% 1/16W	R621	1-218-965-11	RES-CHIP	10K 5% 1/16W
R403	1-217-671-11	METAL CHIP	1 5% 1/10W				
R405	1-218-973-11	RES-CHIP	47K 5% 1/16W	R622	1-218-989-11	RES-CHIP	1M 5% 1/16W
R407	1-216-298-00	METAL CHIP	2.2 5% 1/10W	R623	1-218-981-11	RES-CHIP	220K 5% 1/16W
R408	1-218-990-11	SHORT CHIP	0	R624	1-218-965-11	RES-CHIP	10K 5% 1/16W
				R625	1-218-985-11	RES-CHIP	470K 5% 1/16W
R411	1-208-943-11	METAL CHIP	220K 0.5% 1/16W	R626	1-218-990-11	SHORT CHIP	0
R412	1-208-927-11	METAL CHIP	47K 0.5% 1/16W				
R413	1-218-969-11	RES-CHIP	22K 5% 1/16W	R628	1-218-969-11	RES-CHIP	22K 5% 1/16W
R414	1-218-990-11	SHORT CHIP	0	R629	1-218-973-11	RES-CHIP	47K 5% 1/16W
R415	1-218-985-11	METAL CHIP	470K 0.5% 1/16W	R630	1-218-973-11	RES-CHIP	47K 5% 1/16W
				R632	1-218-977-11	RES-CHIP	100K 5% 1/16W
R417	1-208-935-11	METAL CHIP	100K 0.5% 1/16W	R633	1-218-977-11	RES-CHIP	100K 5% 1/16W
R418	1-208-935-11	METAL CHIP	100K 0.5% 1/16W				
R419	1-218-973-11	RES-CHIP	47K 5% 1/16W	R636	1-218-949-11	RES-CHIP	470 5% 1/16W
R420	1-218-977-11	RES-CHIP	100K 5% 1/16W	R638	1-218-990-11	SHORT CHIP	0
R421	1-218-985-11	METAL CHIP	470K 0.5% 1/16W	R639	1-218-990-11	SHORT CHIP	0
				R640	1-218-990-11	SHORT CHIP	0
R422	1-216-864-11	METAL CHIP	0 5% 1/16W	R641	1-218-990-11	SHORT CHIP	0
R423	1-208-943-11	METAL CHIP	220K 0.5% 1/16W				
R424	1-216-864-11	METAL CHIP	0 5% 1/16W	R642	1-218-990-11	SHORT CHIP	0

Ref. No.	Part No.	Description	Remarks	Ref. No.	Part No.	Description	Remarks
		< VARISTOR >					
VDR401	1-801-864-21	VARISTOR, CHIP (1608)		3-252-232-51	MANUAL, INSTRUCTION (FOR SONIC STAGE,SIMPLE BURNER) (POLISH,CZECH,SLOVAK)(NE1:EE/NE9:EE)		
VDR403	1-801-864-21	VARISTOR, CHIP (1608)		3-252-232-61	MANUAL, INSTRUCTION (FOR SONIC STAGE,SIMPLE BURNER) (KOREAN) (NE1:KR,JE/NE9:KR,JE)		
VDR601	1-801-862-11	VARISTOR, CHIP (1608)					
VDR602	1-801-862-11	VARISTOR, CHIP (1608)		3-252-232-71	MANUAL, INSTRUCTION (FOR SONIC STAGE,SIMPLE BURNER) (ENGLISH) (NE1:US)		
VDR603	1-801-862-11	VARISTOR, CHIP (1608)		3-252-232-81	MANUAL, INSTRUCTION (FOR SONIC STAGE,SIMPLE BURNER) (ENGLISH,FRENCH) (CND)		
VDR802	1-801-862-11	VARISTOR, CHIP (1608)					
		< VIBRATOR >					
X601	1-795-003-21	VIBRATOR, CRYSTAL 16.934MHZ		3-252-309-01	CASE, CHARGE (*)		
X701	1-795-891-21	VIBRATOR, CERAMIC 22MHZ		3-253-604-11	MANUAL, INSTRUCTION (ENGLISH,SPANISH,PORTUGUESE)(NE1:AEP,UK,AUS)		

		MISCELLANEOUS		3-253-604-21	MANUAL, INSTRUCTION (FRENCH,DUTCH,SWEDISH)(NE1:AEP)		

△ 102	X-3380-950-1	OPTICAL PICK-UP (DAX-25E)		3-253-604-31	MANUAL, INSTRUCTION (GERMAN,ITALIAN,FINNISH)(NE1:AEP)		
M901	A-3608-777-A	MOTOR ASSY, TURN TABLE (SPINDLE)		3-253-604-41	MANUAL, INSTRUCTION (ENGLISH,HUNGARIAN,RUSSIAN)(NE1:EE)		
M902	A-3174-850-A	MOTOR ASSY, SLED (SLED)		3-253-604-51	MANUAL, INSTRUCTION (POLISH,CZECH,SLOVAK)(NE1:EE)		
		ACCESSORIES		3-253-604-61	MANUAL, INSTRUCTION (ENGLISH) (NE1:US)		
		*****		3-253-604-71	MANUAL, INSTRUCTION (KOREAN)(NE1:KR,JE)		
△	1-477-496-21	ADAPTOR, AC (AC-ES455K) (NE9:JE)		3-253-604-81	MANUAL, INSTRUCTION (ENGLISH,FRENCH) (NE1:CND)		
△	1-477-496-41	ADAPTOR, AC (AC-ES455K) (NE1:JE/NE9:JE)		3-253-605-11	MANUAL, INSTRUCTION (ENGLISH,CHINESE) (NE1:E18,HK,TW,CH,JE)		
△	1-477-497-21	ADAPTOR, AC (AC-ES455K) (NE9:KR)		3-253-976-11	MANUAL, INSTRUCTION (ENGLISH,CHINESE) (NE1:E18,HK,TW,CH,JE/NE9:E18,HK,TW,CH,JE)		
△	1-477-497-41	ADAPTOR, AC (AC-ES455K) (NE1:KR/NE9:KR)		3-254-273-11	CD-ROM,APPLICATION (NE1:US/CND)		
△	1-477-499-21	ADAPTOR, AC (AC-ES455K) (NE1:CH/NE9:CH)		3-254-273-21	CD-ROM,APPLICATION (NE1:AEP,UK,EE/NE9:AEP,EE,E18)		
△	1-477-500-21	ADAPTOR, AC (AC-ES455K) (NE9:AEP,EE,E18)					
△	1-477-500-41	ADAPTOR, AC (AC-ES455K) (NE1:AEP,EE,E18/NE9:AEP,EE,E18)		3-254-273-31	CD-ROM,APPLICATION (NE1:E18,HK,CR,TW,AUS,CH/NE9:CND,HK,CR,TW,AUS,CH)		
△	1-477-501-21	ADAPTOR, AC (AC-ES455K) (NE9:HK)		3-254-273-41	CD-ROM,APPLICATION (NE1:JE/NE9:JE)		
△	1-477-501-41	ADAPTOR, AC (AC-ES455K) (NE1:UK,HK/NE9:HK)		3-254-767-11	MANUAL, INSTRUCTION (ENGLISH,SPANISH,PORTUGUESE) (NE9:AEP,AUS)		
△	1-477-502-21	ADAPTOR, AC (AC-ES455K) (NE9:CND,TW)		3-254-767-21	MANUAL, INSTRUCTION (FRENCH,DUTCH,SWEDISH) (NE9:AEP)		
△	1-477-502-41	ADAPTOR, AC (AC-ES455K) (NE1:US,CND,TW/NE9:CND,TW)		3-254-767-31	MANUAL, INSTRUCTION (GERMAN,ITALIAN,FINNISH) (NE9:AEP)		
△	1-477-503-11	ADAPTOR, AC (AC-ES455K) (NE1:AUS)		3-254-767-41	MANUAL, INSTRUCTION (ENGLISH,HUNGALIAN,SLOVAK) (NE9:EE)		
△	1-477-503-21	ADAPTOR, AC (AC-ES455K) (NE9:AUS)		3-254-767-51	MANUAL, INSTRUCTION (POLISH,CZECH,SLOVAK) (NE9:EE)		
△	1-477-503-41	ADAPTOR, AC (AC-ES455K) (NE9:AUS)		3-254-767-61	MANUAL, INSTRUCTION (KOREAN)(NE9:KR,JE)		
	1-477-573-11	REMOTE COMMANDER (RM-MC33EL)		3-254-767-71	MANUAL, INSTRUCTION (ENGLISH,FRENCH)(NE9:CND)		
△	1-569-007-12	ADAPTOR, CONVERSION 2P (NE1:JE/NE9:JE)		3-254-769-11	MANUAL, INSTRUCTION (NO INDICATION OF COUNTRY OF ORIGIN) (ENGLISH,CHINESE) (NE9:E18,HK,TW,CH,JE)		
	1-756-120-23	BATTERY, NICKEL HYDROGEN (NE1:AEP,UK,EE,E18,HK,CR,TW,AUS,CH,JE)		8-954-007-91	RECEIVER, EAR MDR-027SP/1 SET (NE1:US)		
	1-756-120-32	BATTERY, NICKEL HYDROGEN (NE1:US,CND)		8-954-008-90	RECEIVER, EAR MDR-E808SP/C SET (EXCEPT NE1:US)		
	1-756-294-11	EXTERNAL BATTERY CASE (NE1:US,CND,UK,EE,HK,CR,AUS,CH,JE/NE9:CND,HK,CR,TW,AUS,CH,JE)					
	1-756-306-22	BATTERY, NICKEL HYDRIGEN (NE9)					
	1-756-342-11	STAND, CHARGE (NE1/NE9:AEP,E18)					
	3-021-018-01	LABEL, FRANCE (NE1:AEP,UK/NE9:AEP,EE,E18)					
	3-235-292-02	POUCH, CARRYING					
	3-252-232-11	MANUAL, INSTRUCTION (ENGLISH,SPANISH,PORTUGUESE) (NE1:AEP,UK,AUS/NE9:AEP,AUS)					
	3-252-648-01	CRIP (REMOTE CONTROL)					
	3-252-232-21	MANUAL, INSTRUCTION (FOR SONIC STAGE,SIMPLE BURNER) (FRENCH,DUTCH,SWEDISH)(NE1:AEP/NE9:AEP)					
	3-252-232-31	MANUAL, INSTRUCTION (FOR SONIC STAGE,SIMPLE BURNER) (GERMAN,ITALIAN,FINNISH)(NE1:AEP/NE9:AEP)					
	3-252-232-41	MANUAL, INSTRUCTION (FOR SONIC STAGE,SIMPLE BURNER) (ENGLISH,HUNGARIAN,RUSSIAN)(NE1:EE/NE9:EE)					

The components identified by mark △ or dotted line with mark △ are critical for safety. Replace only with part number specified.	Les composants identifiés par une marque △ sont critiques pour la sécurité. Ne les remplacer que par une pièce portant le numéro spécifié.
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